



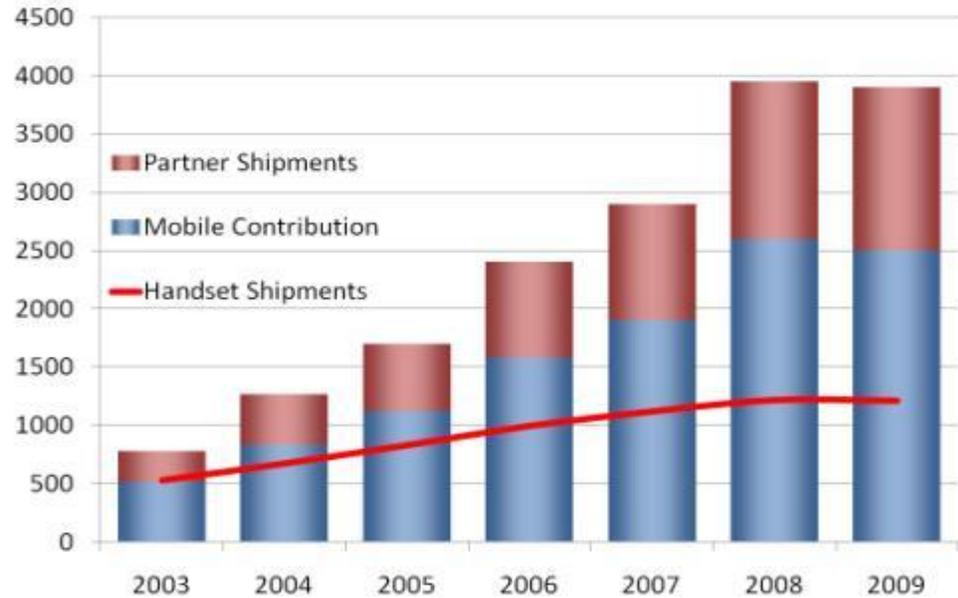
# 典型ARM平台的硬件系统分析

华清远见：蒙洋

# ARM Powers the Mobile World



- } >12 Billion ARM Powered® chips in mobile devices
- } 2.5 Billion ARM Powered chips shipped in 2009
- } Average phone has > 2.0 ARM chips
- } Scalable performance from ULCH to PC
- } CAGR ~ 40% of smartphone predicted until 2013



**Industry units (ex-memory) down ~20%**  
**ARM FY09: 3.9bn units (down ~2%)**



# ARM Cortex Family of Processors



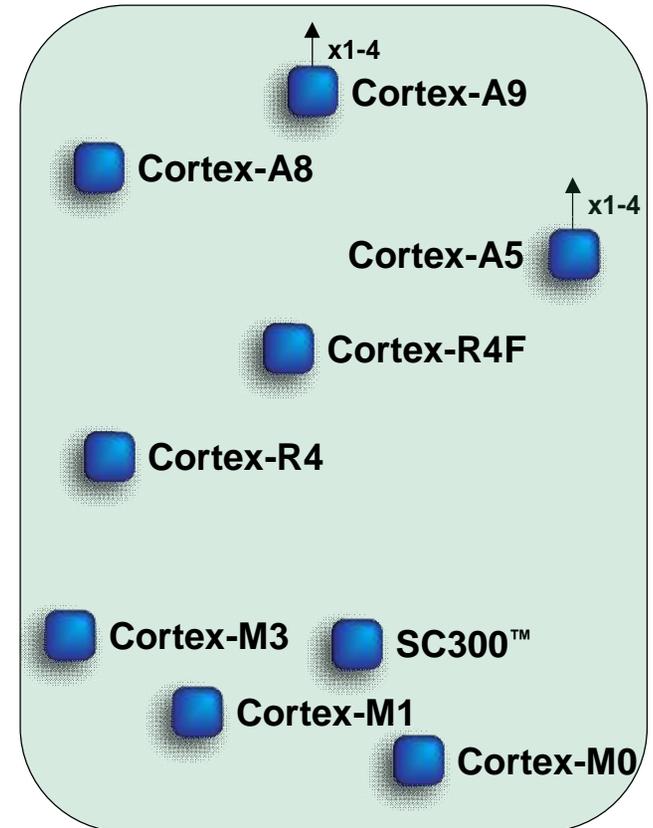
Bringing the benefits of architectural innovation across the computing spectrum

## } ARM Cortex™ -A Series:

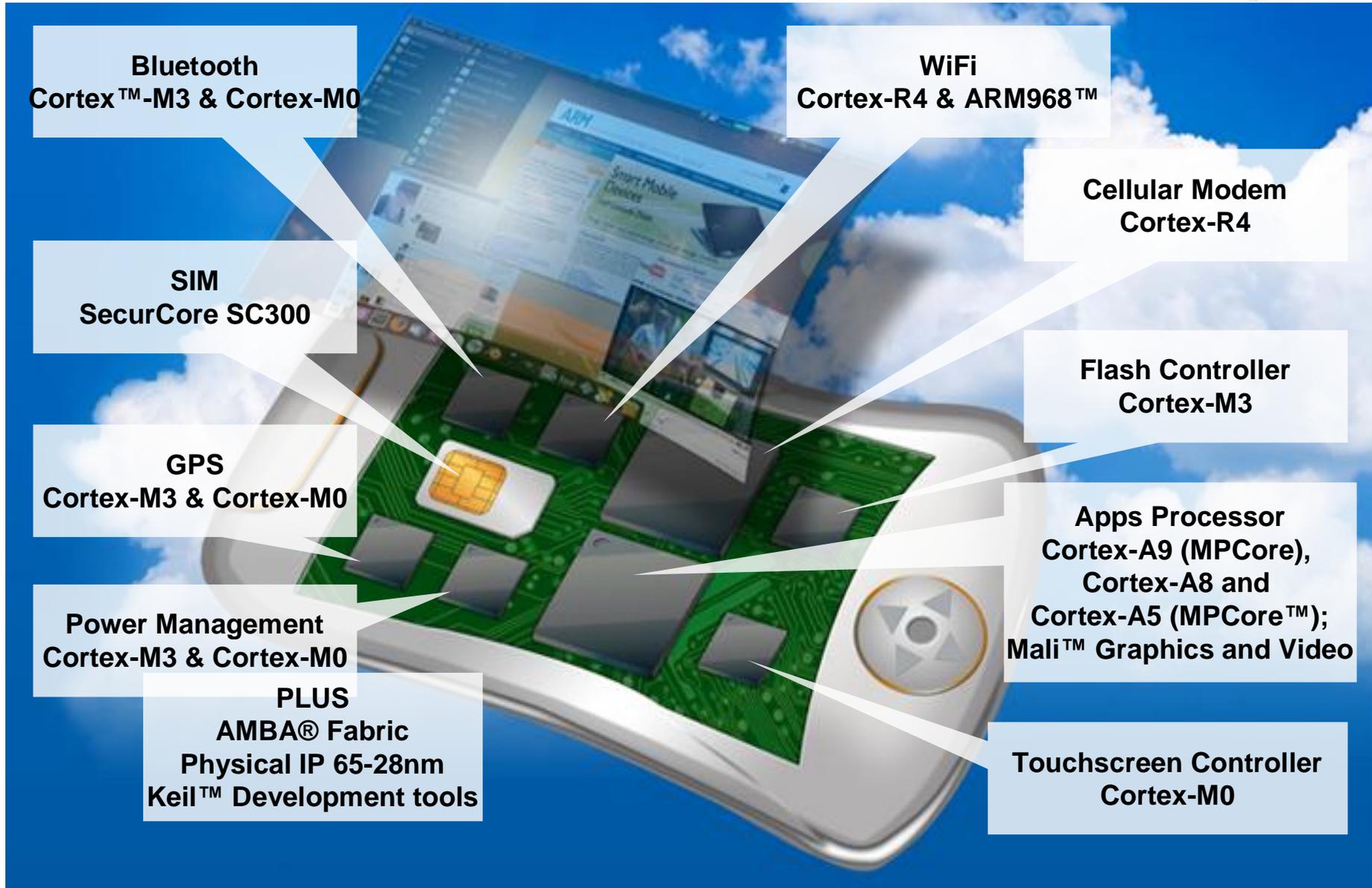
- } Applications processors for complex OS and user applications

## } ARM Cortex-R Series:

- } Embedded processors for real-time signal processing and control applications



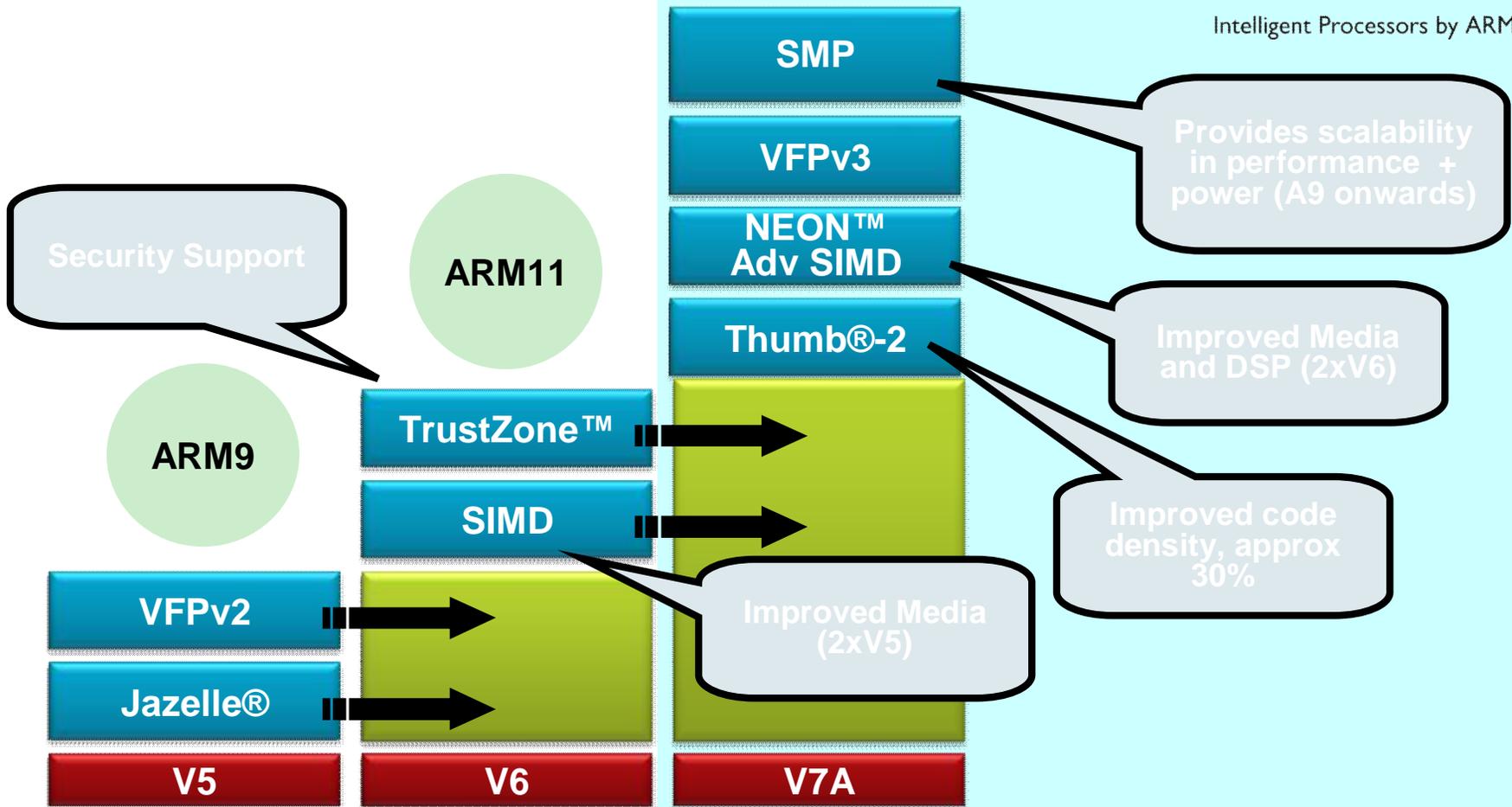
# ARM Powered Smartphone



# Architecture Evolution on ARM



Cortex A8, Cortex-A9,  
QCT Snapdragon, Marvell



# Expect a Wider Smartphone Portfolio



Just some of the Cortex-A class mobile devices announced



Today's advanced handsets are becoming mobile computers

- } Only been 12 months since first ARMv7 handset was announced
- } All the top5 OEMs now have introduced ARMv7 products
- } 2010 smartphone features trickle down to 2013 low-end handset

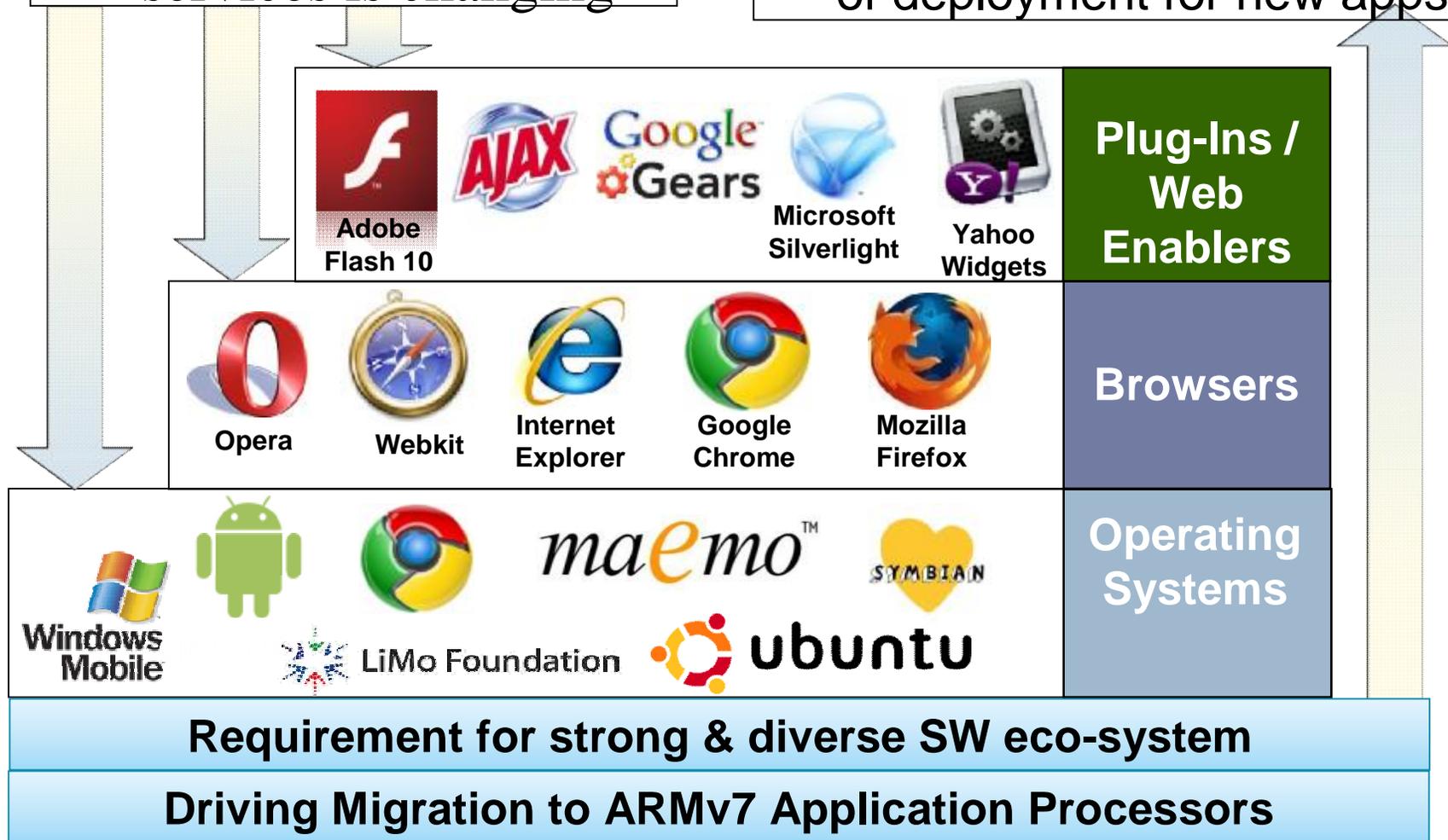


# Delivery of Applications is Changing



Interface for delivery of services is changing

Increased SW layers vs speed of deployment for new apps



# Redefining “Mobile”

- } ARM Cortex devices are defining new categories of mobile products
  - } Chipset variety and multiple operating systems enable product diversity
- } First ARM technology-based mobile computing devices announced by leading OEMs
  - } Mobile computing market expected to grow to 500m units by 2014\*



## Some of the New ARM-based Products Recently Announced



More Announcements  
Expected Through 2010

# Rapid Evolution of Devices



Always Connected  
Smart Mobile Devices

**ARM**<sup>®</sup>

Innovate  
Differentiate  
Competition

Results  
in rich  
selection  
of devices



# Right-Size Computing



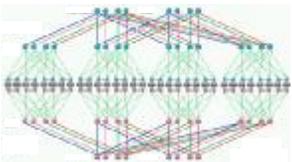
} **CPUs** -- High-performance / low-power CPUs are critical; you don't need high-end level PC processor performance



} **GPUs** -- Critical and are more important for the success of these devices than the CPU. A good GPU can make or break the device.



} **Video** – It is about HD, you can't do it, you can't play. 720p today moving quickly to 1080p



} **Fabric** -- High-performance and efficient SoC design ... memory performance makes or breaks the design

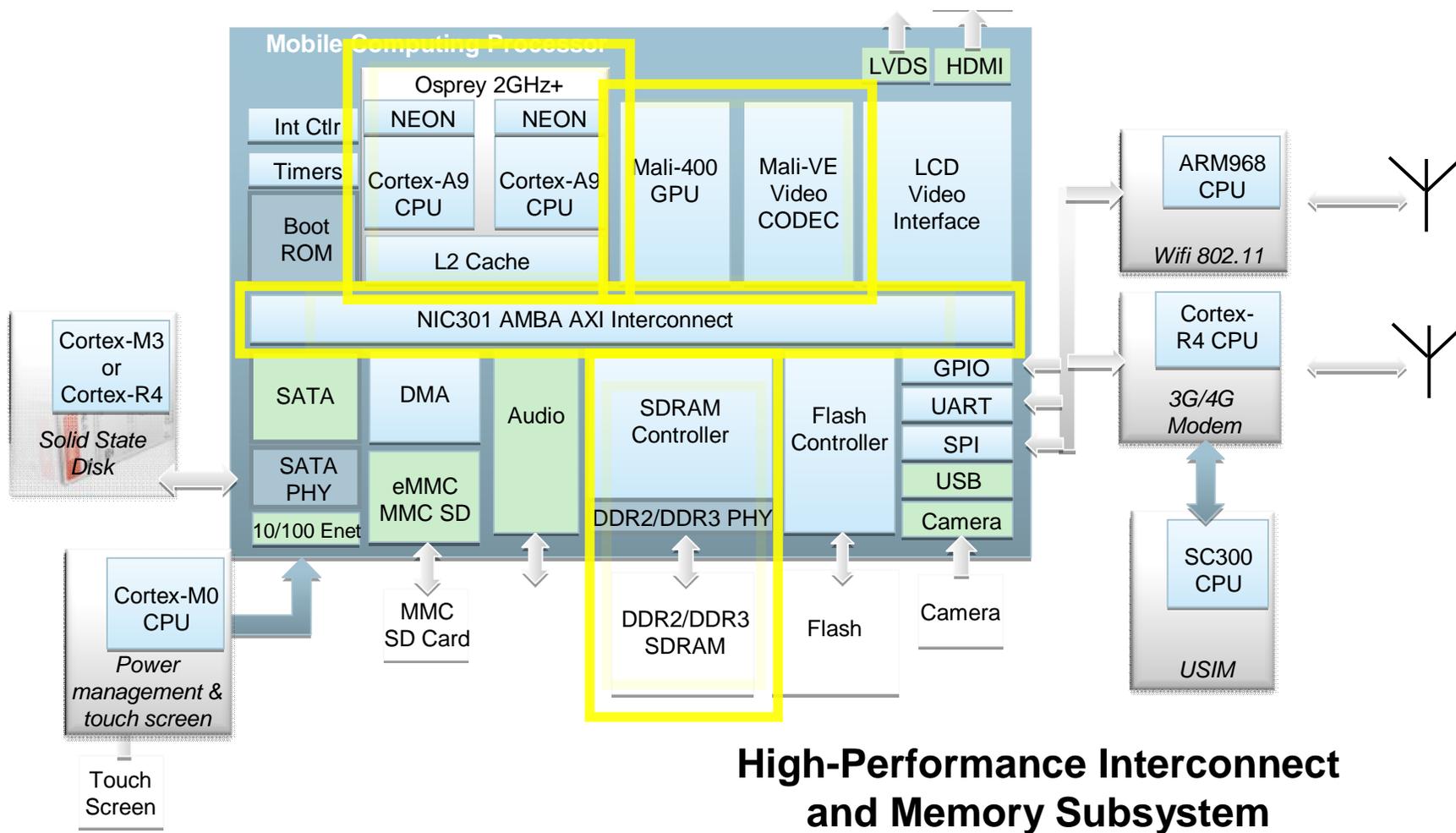


# Key System Components



**ARM v7 Architecture Processor  
Complex with at least 256K L2**

**3D Graphics and HD Video  
Acceleration Blocks**



# Leading Mobile Solutions 2010



## New NVIDIA® Tegra™ Mobile Web Processor

- Dual-core ARM® Cortex-A9 MPCore processor, up to 1.0 GHz
- Ultra low power NVIDIA graphics supporting OpenGL ES 2.0
- Adobe® Flash® 10.1 acceleration
- Full HD multimedia including 1080p encode and decode
- Delivers up to 140 hours of audio and up to 16 hours of HD video playback
- 12 megapixel camera support



## Qualcomm QSD8672

- Custom Dual V7A CPUs, up to 1.5 GHz for faster response and processing
- Low-power 45nm process technology for higher integration and performance
- Higher-resolution WSXGA (1440 x 900) display support
- High-definition (1080p) video recording and playback
- Support for HSPA+ networks – 28 Mbps downloads and 11 Mbps uploads
- Supports CDMA2000 1X, 1xEV-DO Rel 0/A/B networks
- Improved 3D graphics – up to 80M triangles/sec and 500M+ 3D pixels/sec



## ST-Ericsson U8500

- Dual-core ARM® Cortex™-A9 MPCore™ processor
- ARM Mali™ 400 GPU and NEON™ CPU extensions
- Full HD 1080p camcorder, multiple codecs supported (H264 HP, VC-1, MPEG-4)
- Simultaneous dual display support
- High-performance 3D graphics, support for OpenVG 1.1 and OpenGL ES 2.0
- State-of-the-art HSPA (High-Speed Packet Access) with selected HSPA+ features



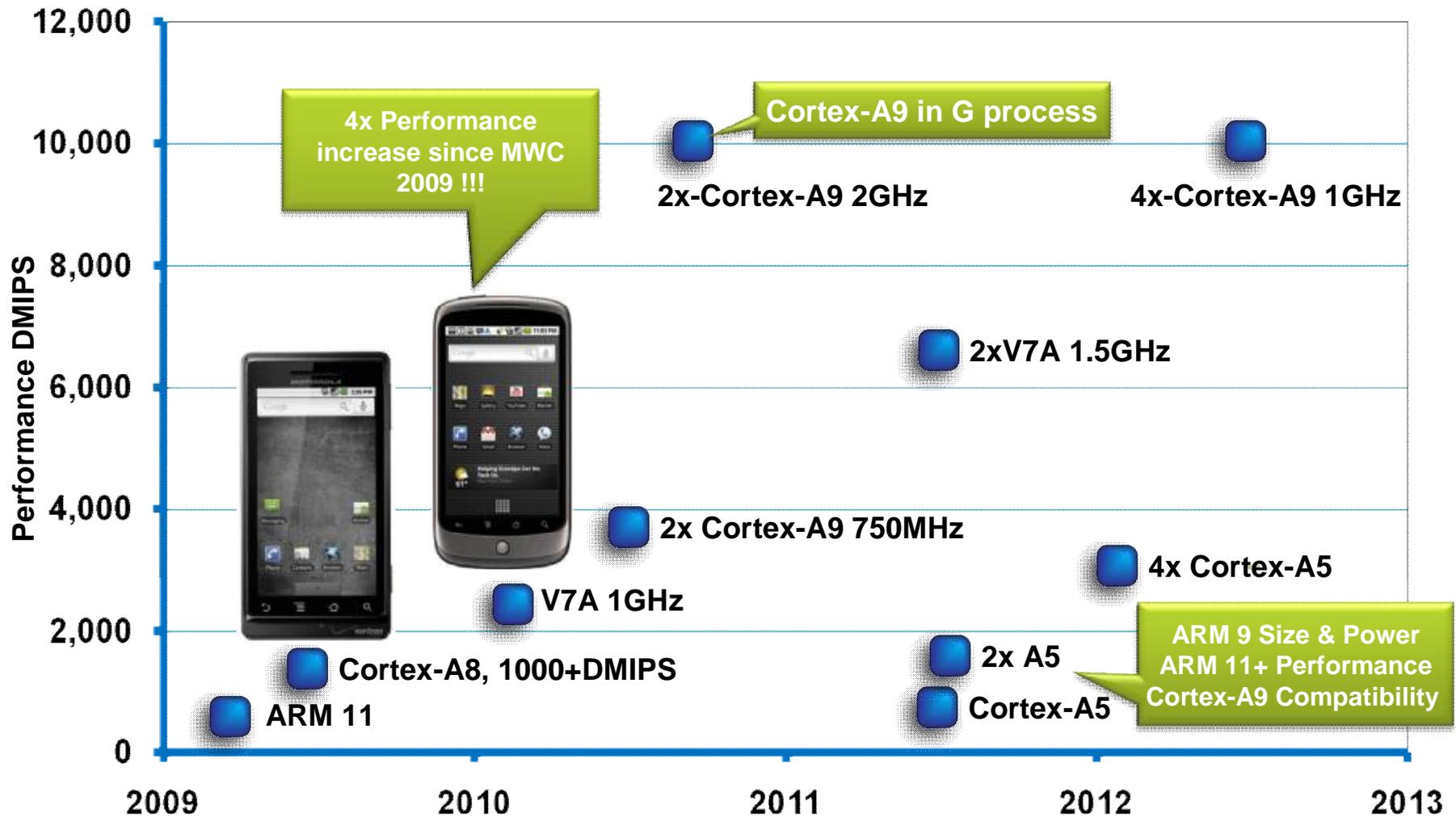
## TI OMAP 4430 Processor

- Dual-core ARM® Cortex™-A9 MPCore™ processor at 1+ GHz with ARM NEON™ technology
- IVA3 multimedia accelerator – enables full 1080p HD video playback and record, running 30fps
- M-Shield™ mobile security technology enhanced with ARM TrustZone® support
- Supports OpenGL® ES v2.0, OpenGL ES v1.1, OpenVG v1.1 and EGL v1.3
- SmartReflex™ 2 technology – Advanced power reduction with dynamic voltage and frequency scaling (DVFS)
- Provides up to 140+ hours of CD-quality audio playback
- Delivers 10+ hours of 1080p HD video playback, 4+ hours of 1080p HD record



# Increasing Performance in Your Phone

Scalable Performance, Scalable Solutions, Scalable Power



# Mobile Client of 2013



## Device trends

- } Evolve to become personal compute platform
- } Console quality gaming
- } Navigation with augmented reality
- } Advanced video capability
- } More web interaction
  - } Content & applications delivered using HTML5 & FP10
- } Fast broadband
  - } Enterprise applications
  - } Advanced multi-processing drives new consumer paradigms and uses
- } Fast battery charge



## Apps processor

- } Multicore, GHz solutions
- } No change to 300mW power budget
- } New generation MP with greater dynamic range of performance
- } 22nm
- } New generation GPU
- } Isolation of applications & secure payment

## Modem

- } LTE 100Mbps
- } New-generation processor to handle high data rates

# Best Software Solution for Mobile?



## PC Legacy on x86

- § Software designed for PCs
  - § Windows focused
  - § PC form factor focused
  - § Designed for Core2 Duo+
  - § Non optimised for power
- § Only one mobile O/S
  - § Moblin
  - § Still not shipped on a mobile phone
- § Moblin Garage App Store
  - § Trying to bridge Atom performance gap
  - § <100 applications on Moblin Garage
- § Embracing QT
  - § Hoping to build upon ARM ecosystem momentum

## Innovation on ARM

- § Software designed for mobile
  - § 15+ years of power optimized software
  - § Software designed for mobile experience
  - § Utilizing location, camera, always on, always connected ...
- § Multiple mobile O/Ss
  - § Driving innovation and diversity
  - § Many now open source
  - § Production proven
- § Vibrant application stores
  - § Hundreds of thousands of mobile phone applications on multiple operating systems and store fronts

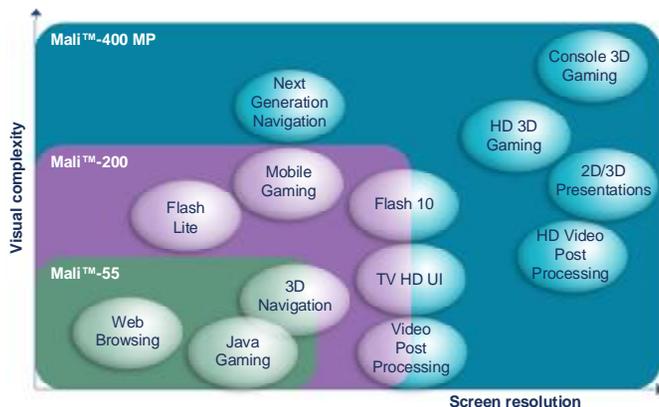


# Choosing the right architecture?

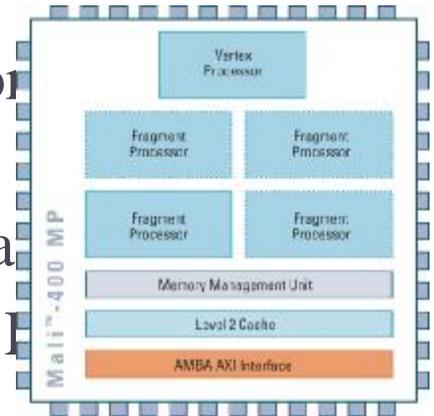


- } Designing for OpenGL ES 2.0 and OpenVG 1.1
  - } Geometry load constant, pixel processing scales with screen resolution
  - } No additional geometry overhead when scaling pixel performance

## } Separate Mali geometry & pixel processors



Scaling - optimum configuration for  
on through independent clock gate  
an “unified” shader for OpenGL ES 2.0



# Future Technology Directions



- } Energy efficiency and high performance
  - } Focus on memory bandwidth usage
  
- } Area efficiency and flexibility/re-use
  - } Multicore designs for scalable performance solutions
  - } General Purpose computing on Graphics Processing Units (GPGPU)
  - } Embedded application: image post-processing
  
- } Composition software will be key
  - } How to mix Audio, Video, 2-D graphics, 3-D graphics, UI, etc.
  
- } 2012 graphics architecture changes will be driven by new functionality
  - } E.g. 2<sup>nd</sup> generation GPGPU, OpenCL and geometry shader
  - } Note: none of this is supported in current OpenGL ES standards
  - } OpenGL ES 3.x specification will not complete until 2012



# Porting Premium Games on Mali



Airplay is a unique technology from Ideaworks3D, delivering console-quality gaming to any ARM and Mali based platform.



ARM recently announced investment in Ideaworks3D

- q Ideaworks3D Store Front on Mali
- q Project Gotham Racing
- q Resident Evil
- q Fishlabs – Powerboat challenge iPhone game



Mali200 platforms (OpenGL ES 2.0) deliver an experience comparable to current-generation consoles.



# Next-generation 2D and 3D Navigation



- } **Working with TomTom and other middleware providers (next-generation PNDs)**



- } Acceleration of navigation elements through Mali OpenGL ES
  - } Textured roads
  - } Digital terrain modelling, fogs effects
  - } Elevated roads on landscapes, road intersection
  - } 3D birds-eye view, realistic road signs



- } Joint project with TomTom on Mali-55 and Mali-400 based platforms:
  - } OpenGL ES 1.1 for map rendering
  - } OpenVG for font rendering and Webkit
  - } OpenGL ES 2.0 for 3D junction view



# Browser Acceleration



} Working with Opera and Mozilla to provide a rich browsing experience

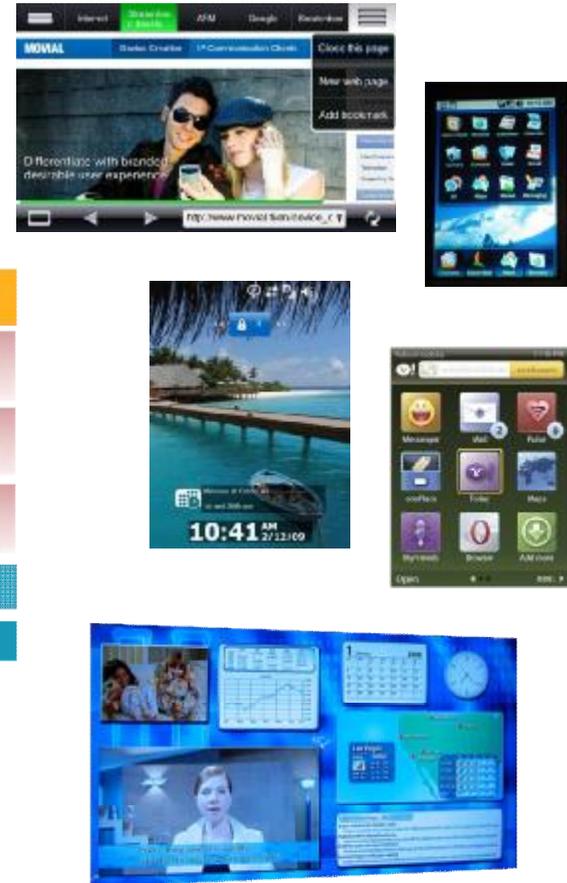
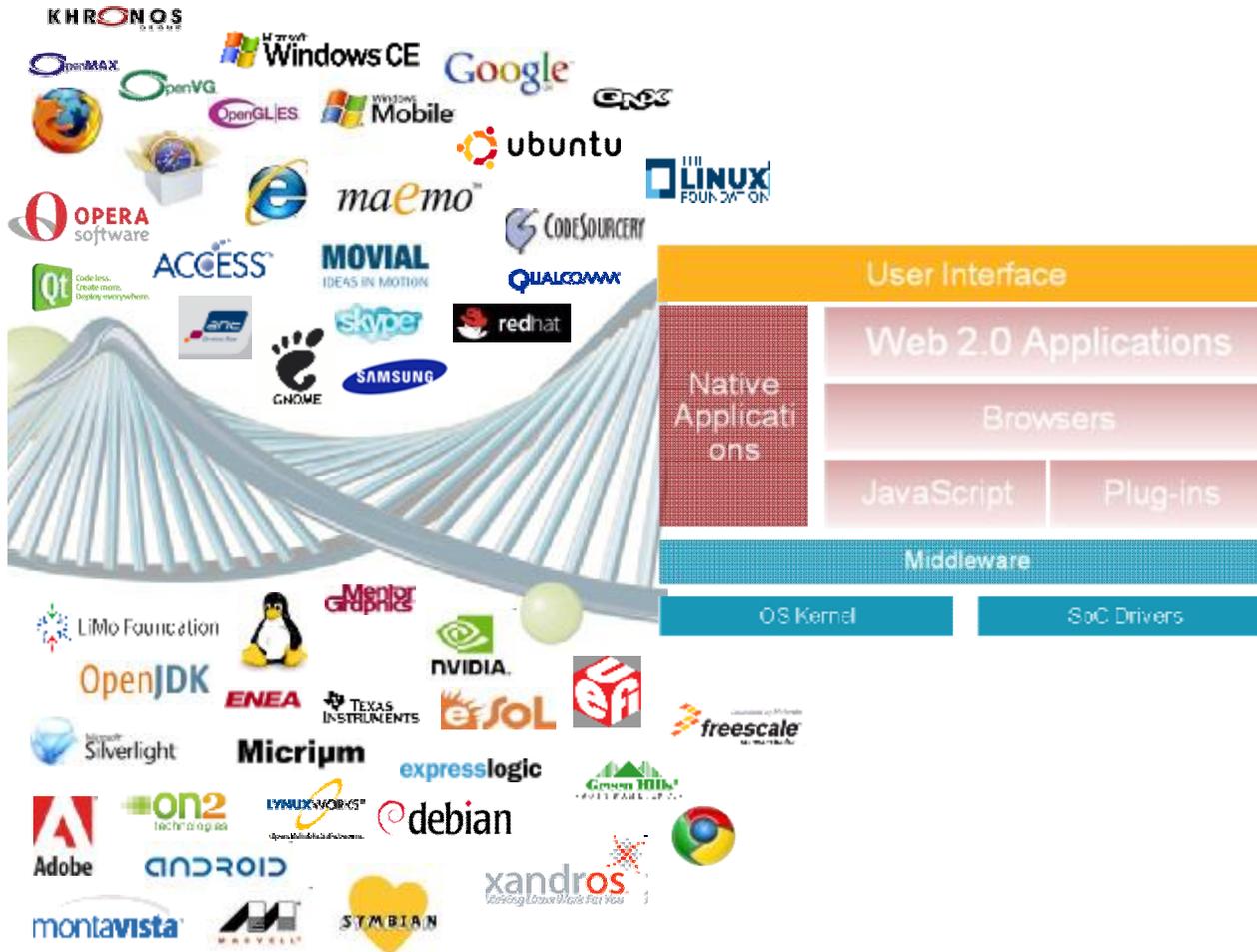


} Key activities

- } Benchmarking browser experience on Mali
- } Optimisation suggestions for usage with hardware acceleration
- } Implementing use-cases and benchmark tests



# ARM Software Ecosystem



# Priority Enablement Projects



- } Many ongoing engagements
  - } Linux Kernel, GCC, etc...

OpenJDK

- } Priority projects for update
  - } Java and JavaScript
  - } Browsers
  - } Android/ChromeOS
  - } Flash 10



mozilla  
**Firefox**



# JavaScript Acceleration



} 2009 was the year that JavaScript performance *accelerated*

} 4 Key Open Source Projects to accelerate

} “TraceMonkey” – Mozilla Foundation

} “Tamarin”- Adobe

} “Squirrel Fish (Extreme)”- WebKit

} “V-8”- Google

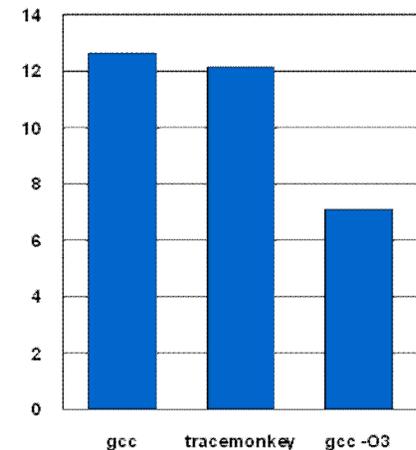


§ All accelerate JavaScript by compiling it to native code (JIT)

§ Some yield up to 5X+ performance improvement

§ Example: Factorial is faster than non-optimized C

factorial



# Mozilla Firefox and Fennec Browsers



- } Targets Smartbooks, Smartphones, DTV's...
  - } ARM created enhanced "Tamarin" nano JIT code generator
  - } ARM optimized Cairo graphics for NEON
  - } ARM is working with Mozilla to add OpenGL ES 2.0



- } Firefox 3.5 up to 2x faster\* than Firefox 3.0



- } 7x JavaScript improvement between Firefox 3.0 and 3.5

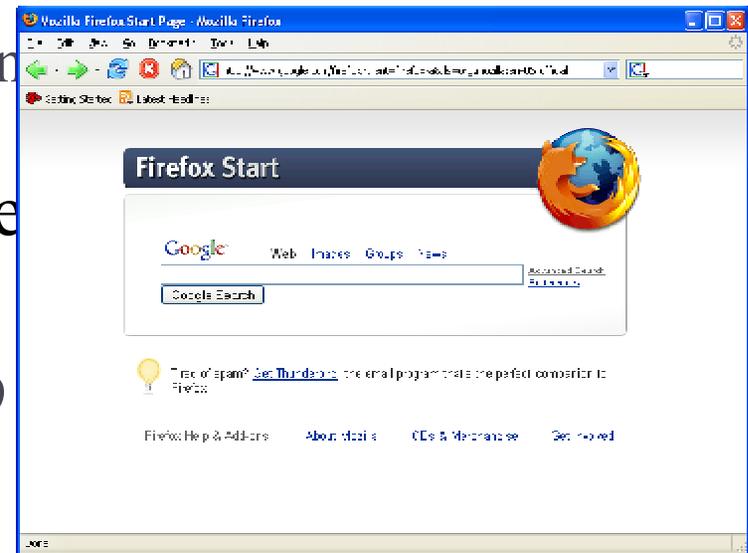
- } Release schedule parity with Internet Explorer

- } Firefox 3.6 Dec 2009

- } Fennec scheduled for Nov 2009



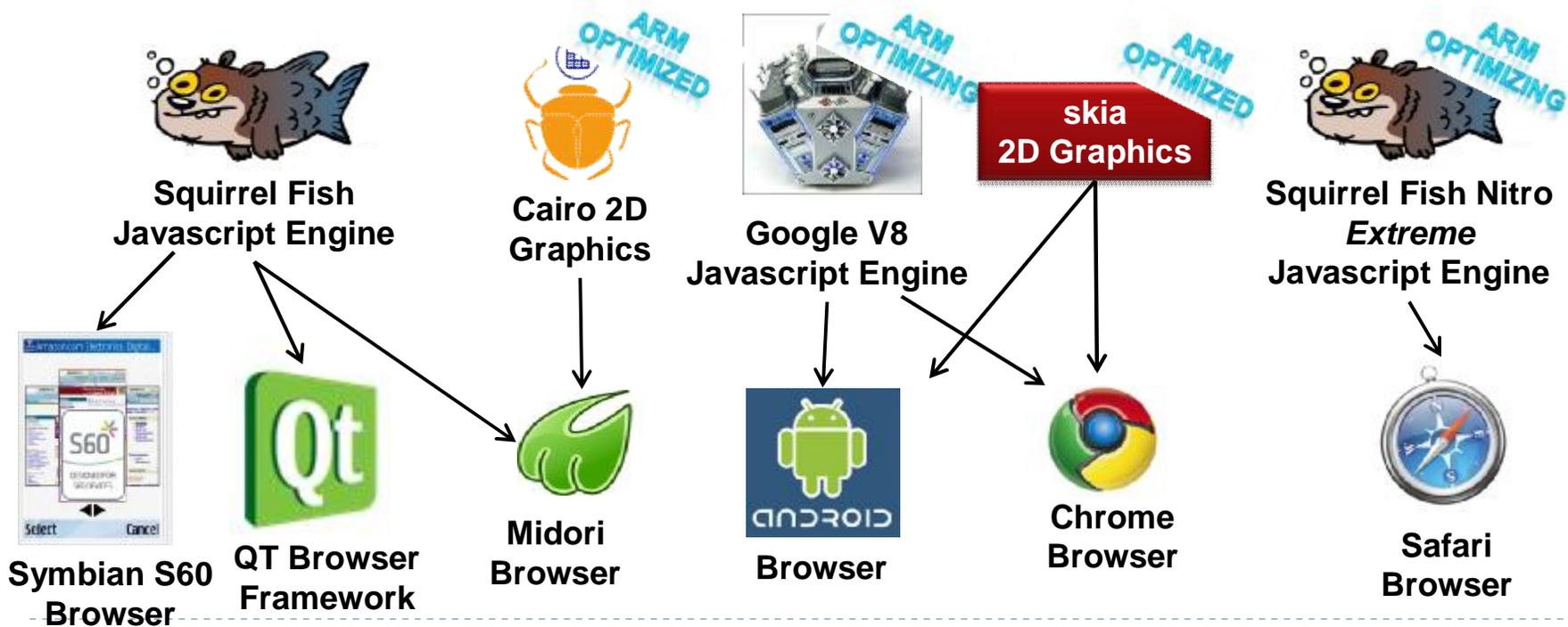
\* Sunspider benchmark



# Webkit - Advanced Browser Framework

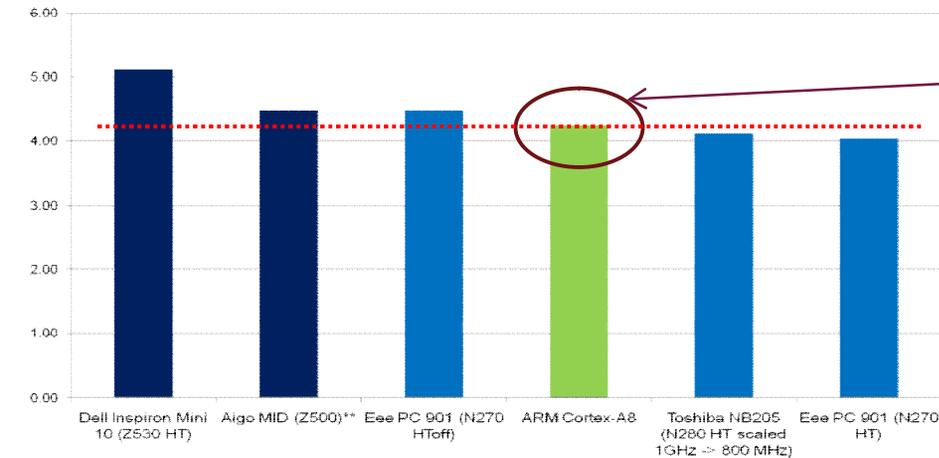


- } Webkit forms the basis for >6 browsers on ARM
- } Webkit framework has 2 parts
  - } WebCore – supports different graphics libraries
  - } JavaScriptCore – supports different JavaScript Engines
- } ARM is optimizing key libraries and engines

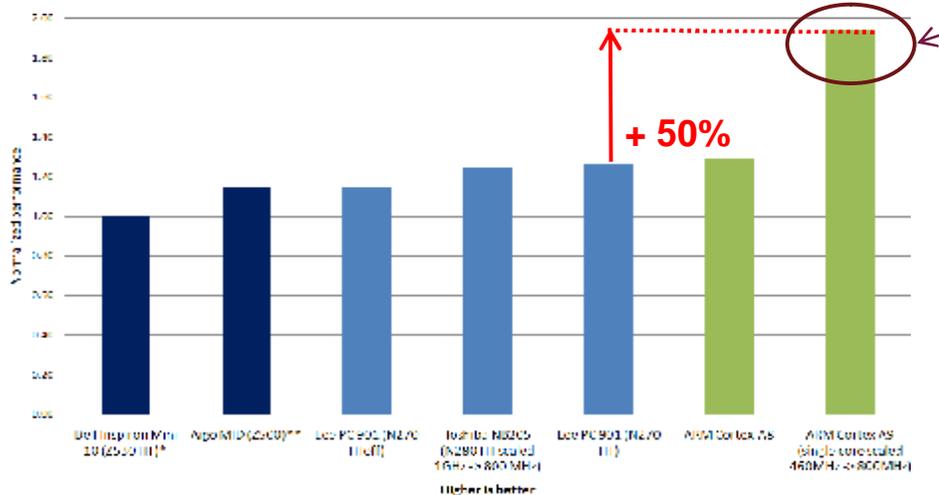


# Browsing on ARM Surpassing Intel

## Cortex Web Page Rendering vs. Atom



Cortex-A8 delivers similar performance of Atom at much lower power



§ Cortex-A9 is 50% better than Atom at same MHz

Average web page load times (Bbench Suite)

Test platform: ARM Cortex A8-based SoC, gcc 4.3.3  
 Intel Atom-based netbooks running Linux  
 Benchmark: Bbench browser workload, Firefox 3.5

# ARM Innovating with Google



} Android and Chrome OS target ARM from the



- § Google, ARM and other OHA Partners deliver more ARM optimizations with each Android and Chrome OS release
- § Staying with the mainline allows access to the latest features

**ARM Architecture is the Only One That Will Ship On Android & Chrome**



# Android and ARM Inseparable



} Android was developed for and shipping exclusively on ARM

↳ from the Android prototype to the Motorola Droid and Nexus One



} Android is optimized for ARM

} 1,200 files of assembler code.

} 20,000 or 28% of Bionic libraries are ARM assembler

} 6,300 C & 4,900 C++ files many with ARM optimizations

} There are 268 companies and entities contributing code to the ARM Android codebase.

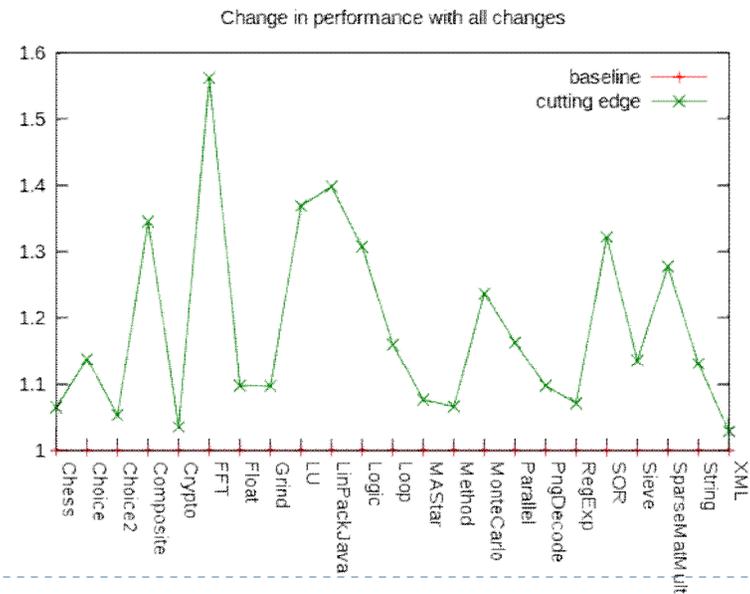


# Google Dalvik Java VM Optimizations



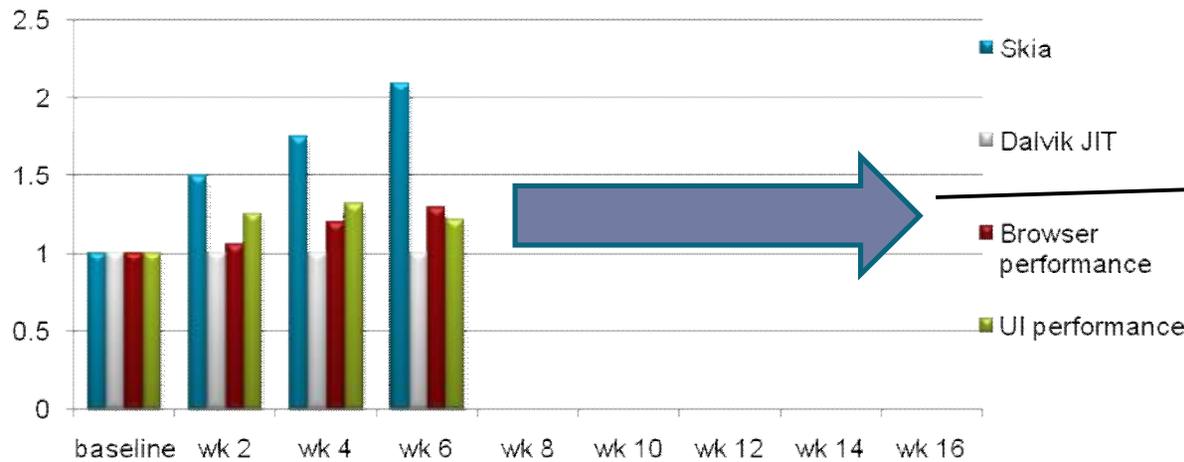
- } Dalvik JIT announced publically at Google-IO May '09
- } Google has partnered with ARM on Dalvik open source project
  - } Initially work on interpreter improvements yield **>10% Uplift**
  - } ARM working on JIT contributions to code generation
    - } ARMv7 Thumb2 and Thumb-2 EE (as appropriate)

Cumulative improvement  
ARMv7T interpreter over ARMv5T  
EEMBC Grinderbench



# Cumulative Android Neon Optimization Impact

## Android optimizations for ARM architecture



**Optimization and Benchmarking work Continues to improve Performance**

- } In Android and Chrome, Skia 2D graphics lib and Dalvik JIT are critical
  - } Some Skia routines see as much as 500% lift from Neon
  - } Overall performance improvement of 30% in UI, 10~30% in browser use cases due to Neon optimized Skia
    - } Benefit increases at higher screen resolution

Notes: Test platform: Cortex A9, PL310 L2, 4:1 memory system, Android OS, gcc 4.3.3

Benchmark: Skia graphics lib, Bbench browser workload, Dalvik JIT

# Adobe Flash Player Technology



The worlds most popular web Rich Content delivery vehicle



Vector & raster graphics rendering via software and hardware engines



Bi-directional audio & video streaming via Audio and Video codecs



Execution of ActionScript programs via Tamarin Central Virtual Machine

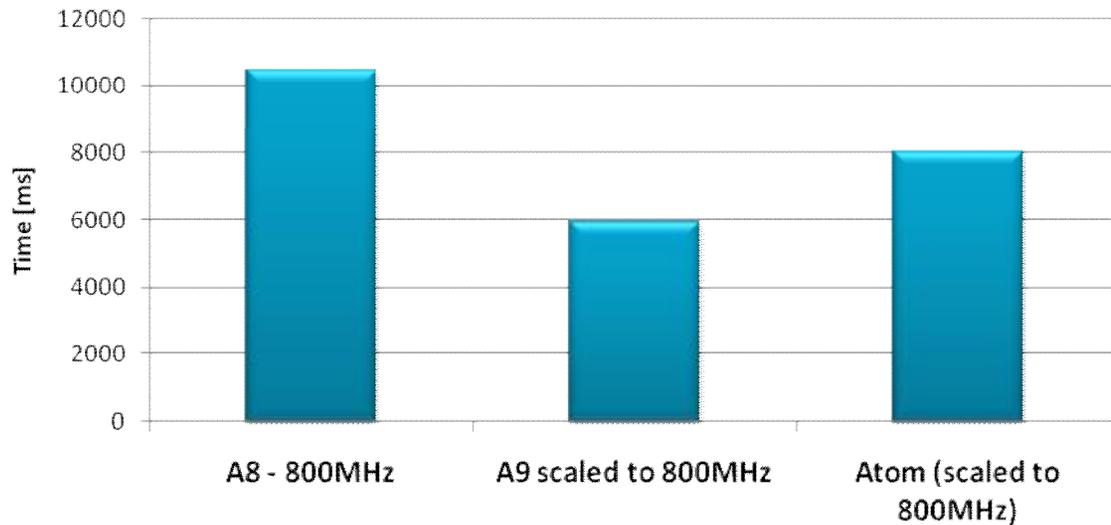
§ Three core technology threads as part of Flash



# Flash Player 10 – ActionScript 3.0



Sunspider (total)



§ 50%+ speedup from original NanoJIT to current version

§ Applies to both A8 and A9

§ A9 36% faster than Atom at same speed

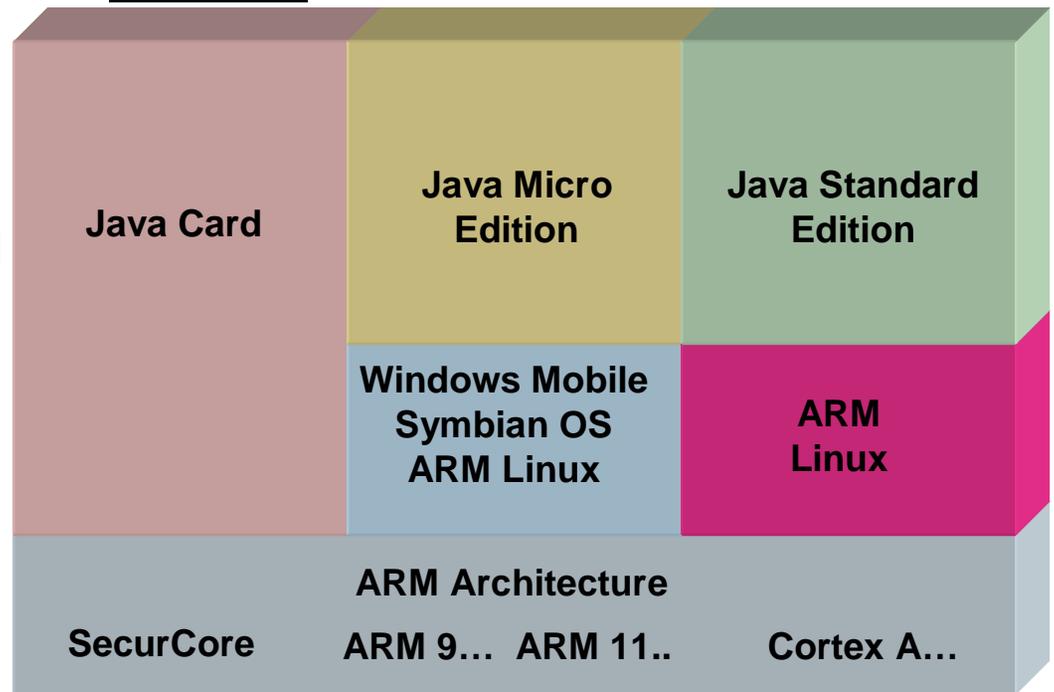
§ A9 76% faster than Cortex-A8

Test platform: ARM Cortex-A8 based SoC at 800MHz, ARM Cortex-A9 test chip dev platform at 460MHz (scaled to 800MHz for comparison), ARM Linux, gcc 4.4.3  
Benchmark: Actionscript running Sunspider



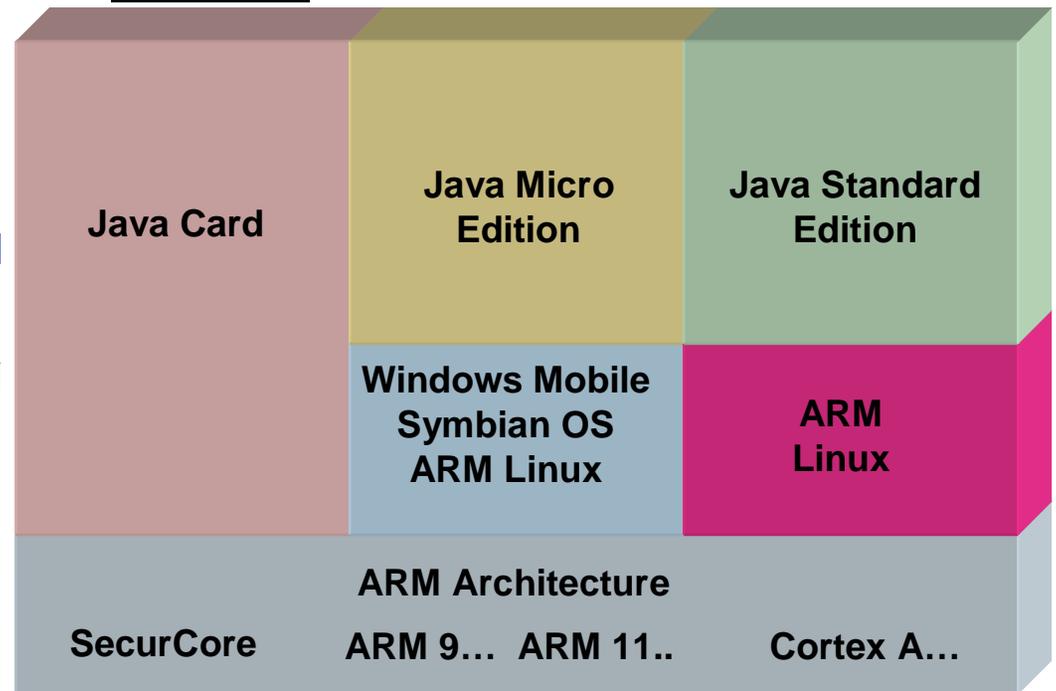
# Java Standard Edition on ARM

- } Java Standard Edition v6.10 (ARM) available from Sun since Q1 2009
  - } For ARM Linux 2.6.22 and above
- } Full Desktop Java for ARM
  - } Includes C1 Client Hotspot JIT
  - } Powers Java Applets in browser
  - } Powers many desktop apps
  - } Popular in Enterprise front-ends



# OpenJDK (IcedTea) on ARM

- } ARM is driving optimization via Ubuntu
  - } Added optimized ARM Assembly interpreter for Ubuntu – 4x speedup
- } OpenJDK optimizations in Karmic
  - } Accepted by Canonical
  - } Pushed upstream to IcedTea
- } **Free** Open Source Java
  - } Complete implementation
  - } Java TCK compliant



# 议题

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ARM处理器概述



ARM平台硬件结构分析

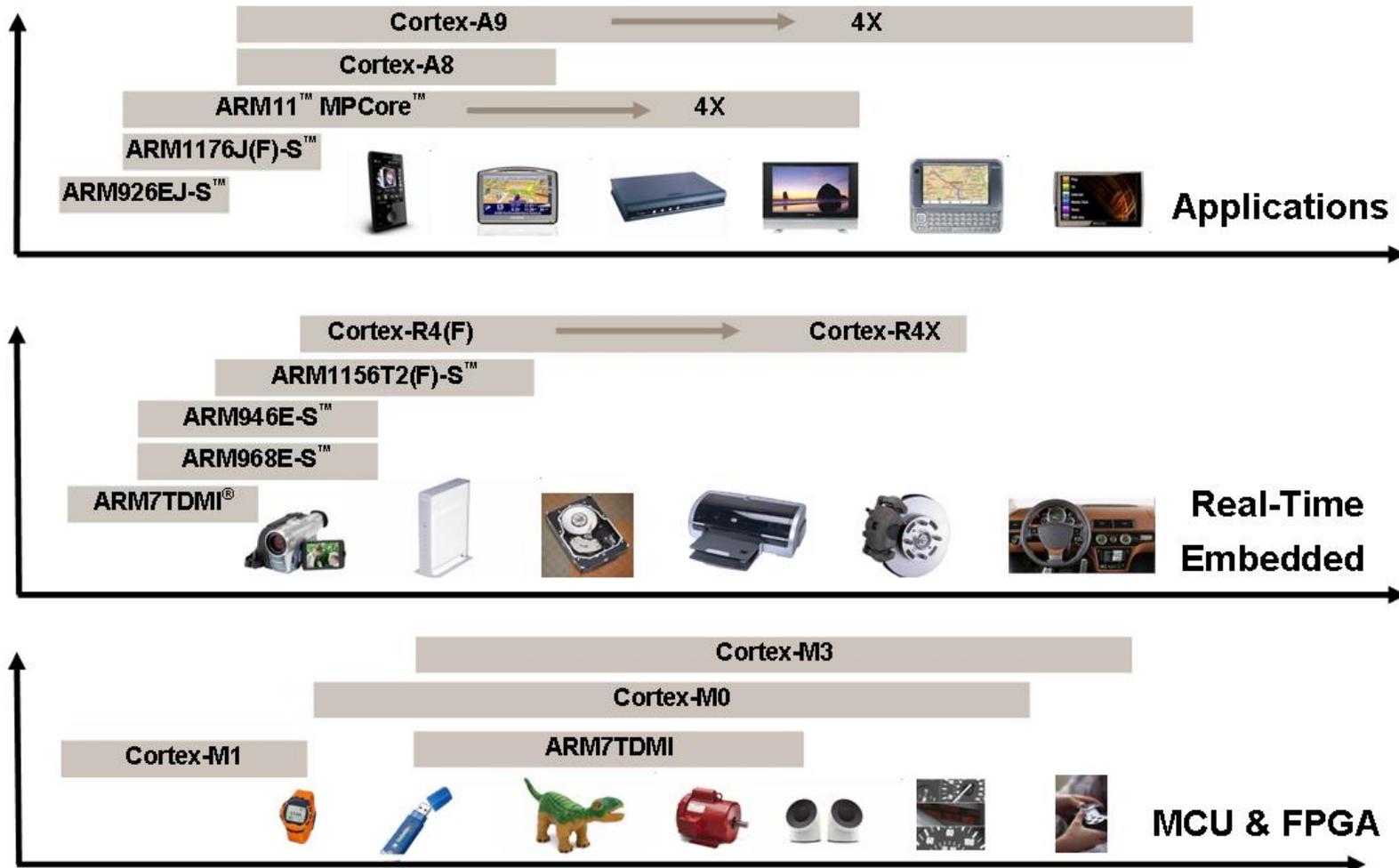


ARM linux系统典型应用案例

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# ARM处理器的应用



# ARM体系结构的发展



Halfword and signed halfword / byte support  
System mode  
Thumb instruction set



Improved ARM/Thumb Interworking  
CLZ  
Saturated arithmetic  
DSP multiply-accumulate instructions

**Extensions:**  
Jazelle (5TEJ)



SIMD Instructions  
Multi-processing  
v6 Memory architecture  
Unaligned data support

**Extensions:**  
Thumb-2 (6T2)  
TrustZone (6Z)  
Multicore (6K)  
Thumb only (6-M)



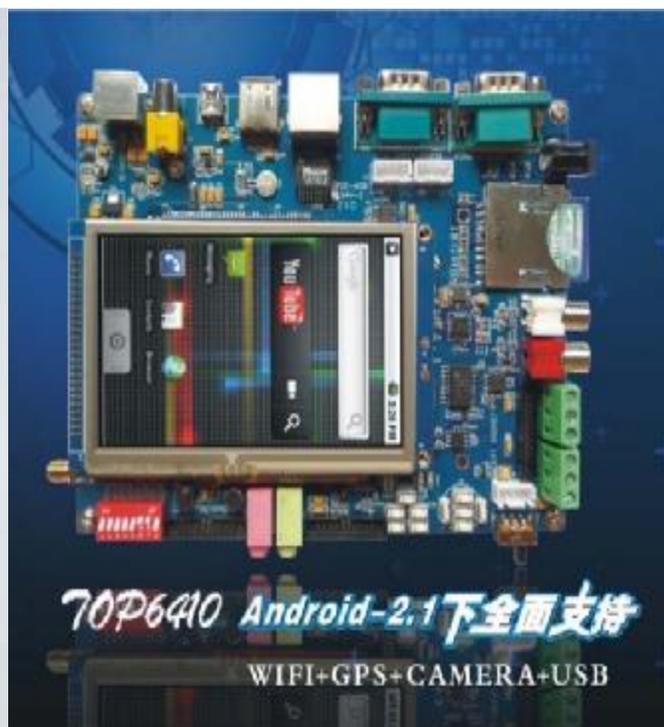
Thumb-2  
NEON  
TrustZone

**Architecture Profiles:**  
**7-A (Applications) :** NEON  
**7-R (Real-time):** Hardware divide  
**7-M (Microcontroller):** Hardware divide, Thumb-2 only

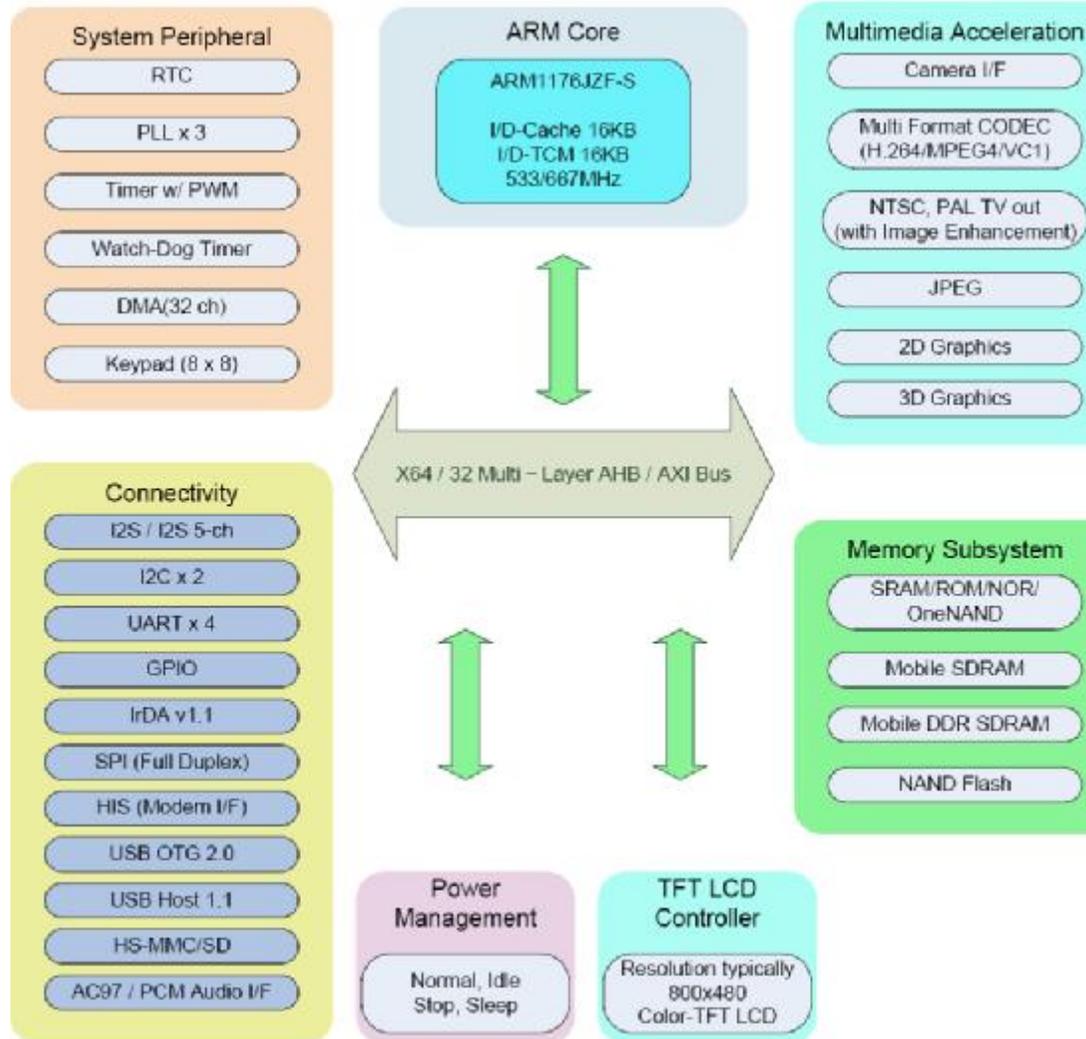


# 全新TOP6410单板机接口设计

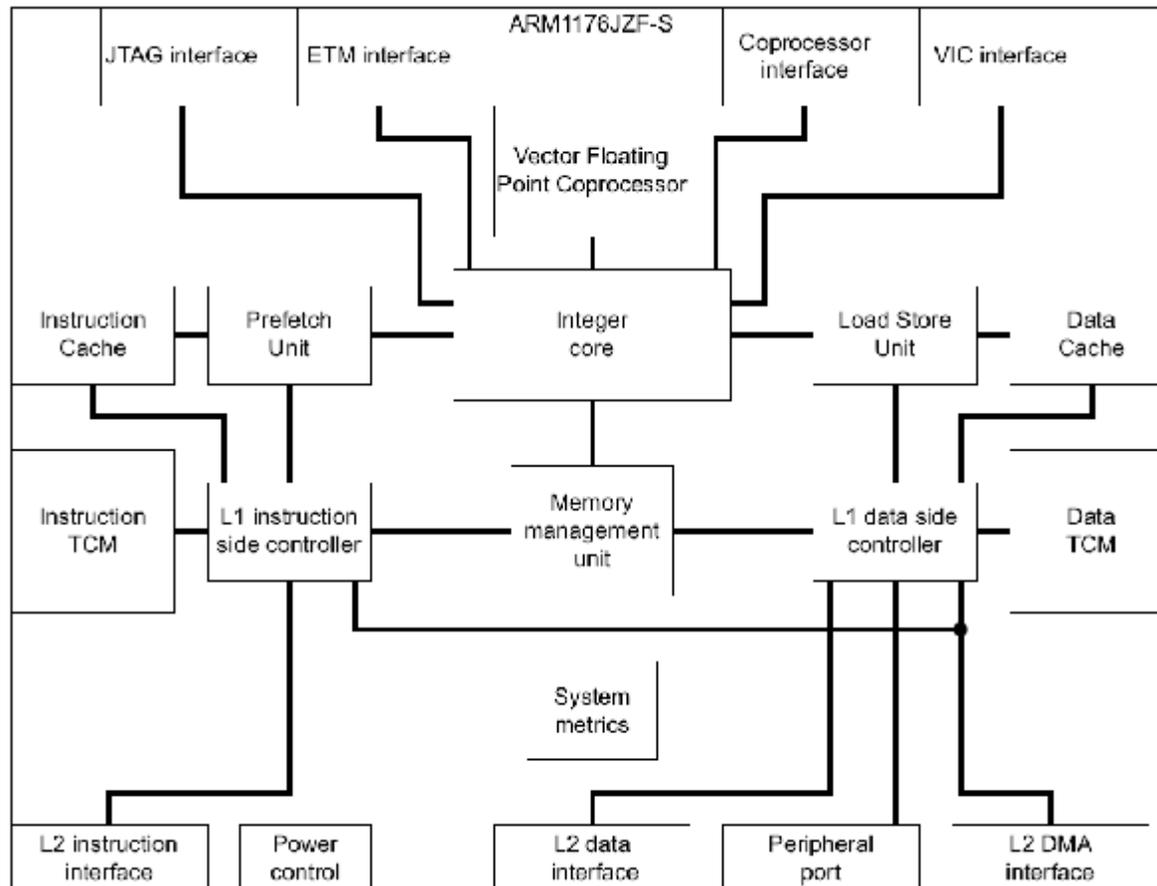
- } 基于S3C6410处理器
  - } ARM1176JZF-S内核
  - } ARM V6指令集



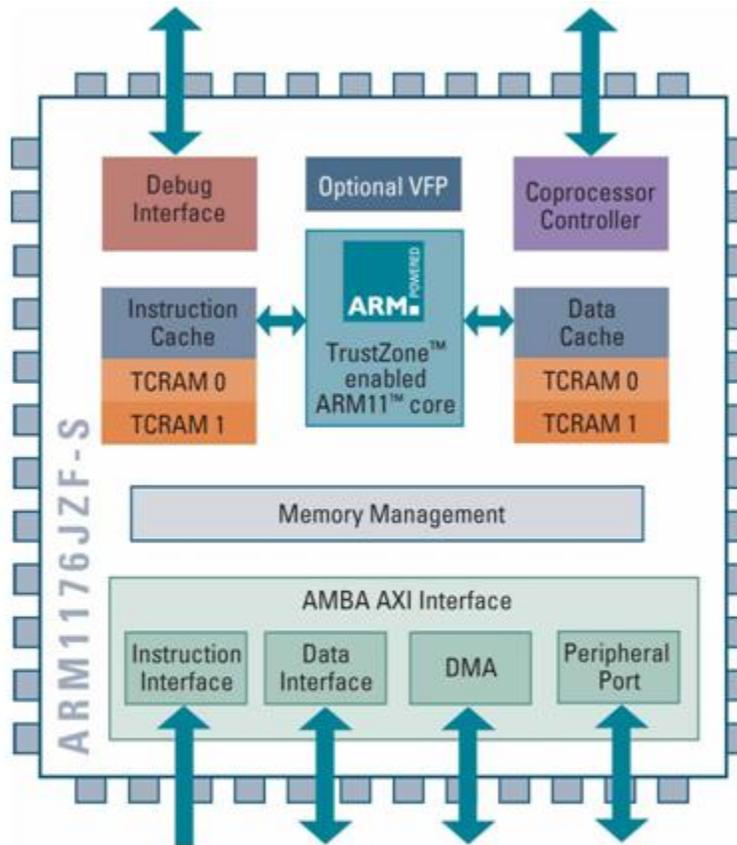
# S3C6410内部结构图



# ARM1176JZF-S 处理器框图



# ARM1176JZF-S特性

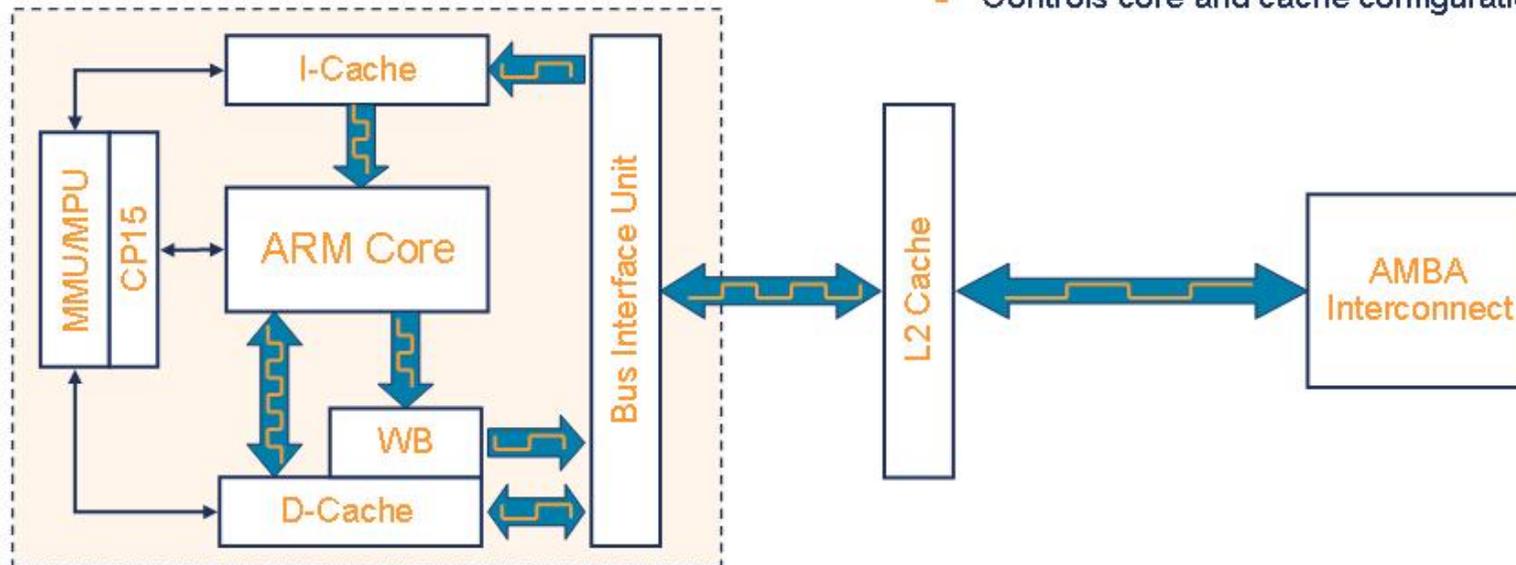


- **ARM1176JZ(F)-S**
  - Architecture v6Z - TrustZone
  - 8-stage pipeline
    - Load/Store Unit separate from ALU
    - Static and dynamic branch prediction
  - Physically-tagged 4-64k caches
  - Dual configurable TCMs
  - Memory management unit
  - Four AXI memory ports
  - Jazelle-DBX support
  - Intelligent Energy Management (IEM)
  - Optional integrated VFP coprocessor
  
- **ARM1136J(F)-S (not shown here)**
  - AHB memory interface
  - No TrustZone support
  - Single TCMs

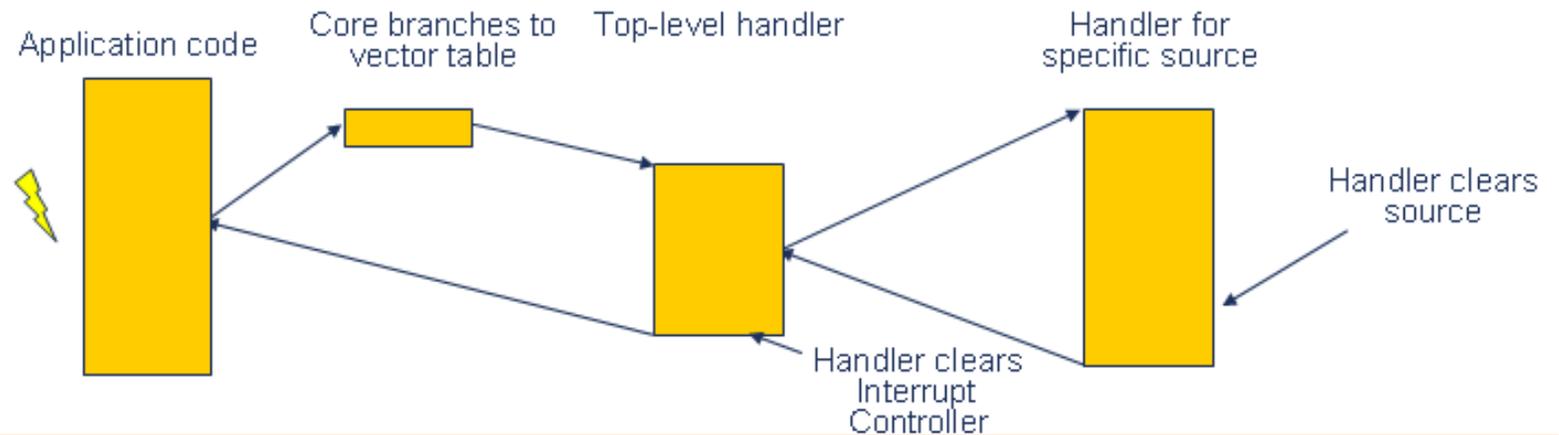
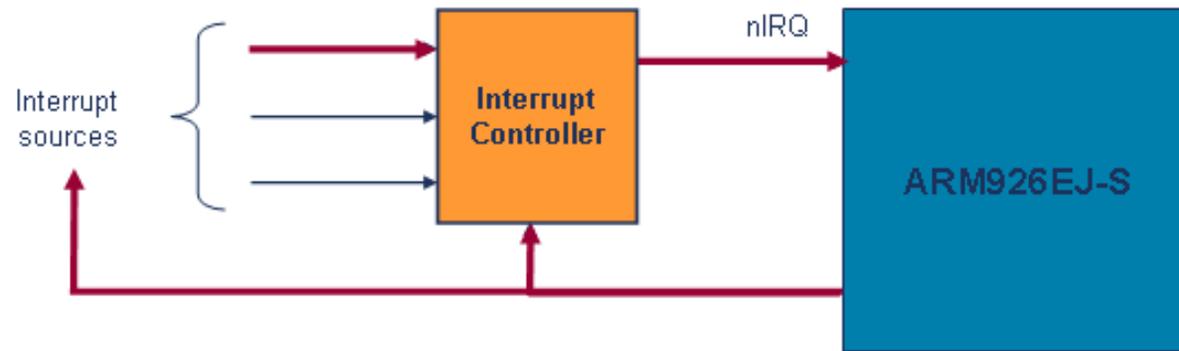


# ARM核存储系统

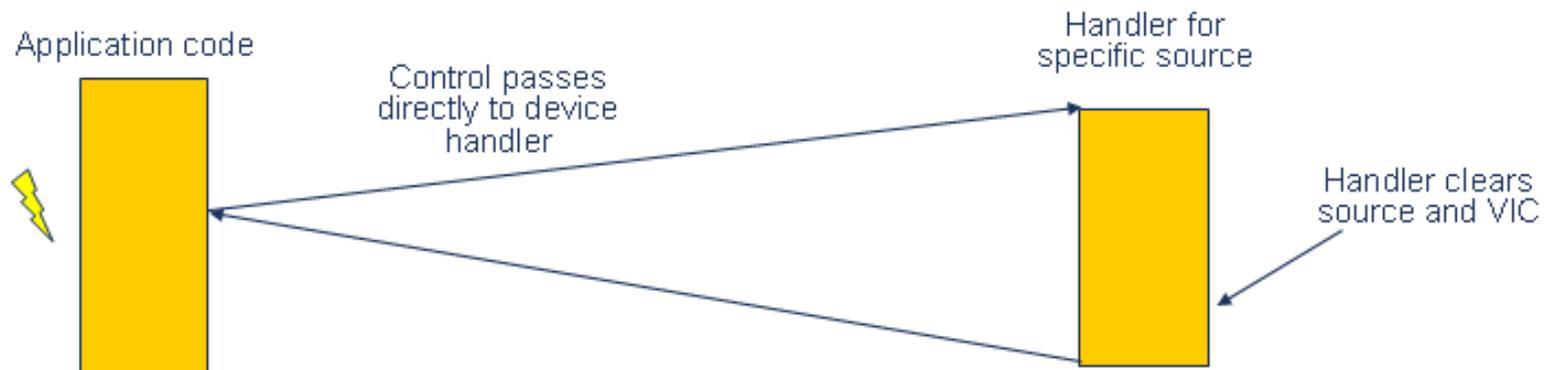
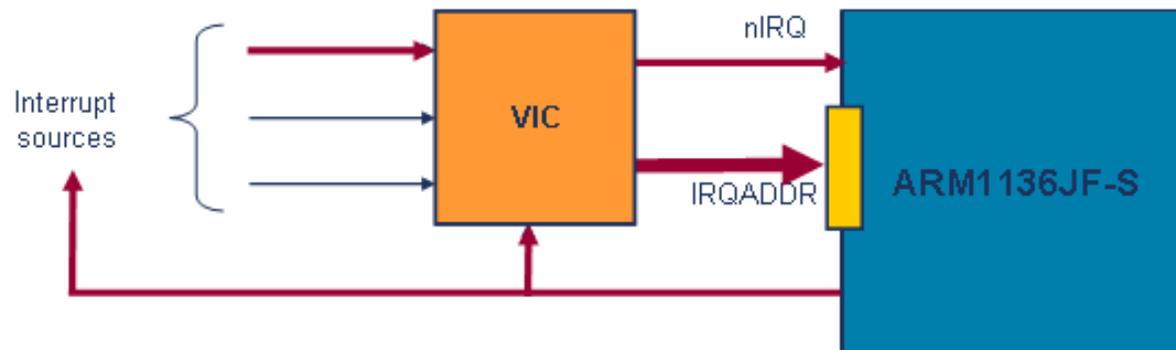
- **MPU – Memory Protection Unit**
  - Controls memory access permissions
  - Controls cacheable and bufferable attributes for memory regions
- **MMU – Memory Management Unit**
  - Has all the features of an MPU
  - Also provides Virtual to Physical address translation
- **Cache**
  - Fast local memory
  - Holds copies of recently accessed memory locations
- **Write buffer**
  - Decouples writes to cache and external memory
- **CP15 - System Control Coprocessor**
  - Controls core and cache configurations



# 传统中断控制系统

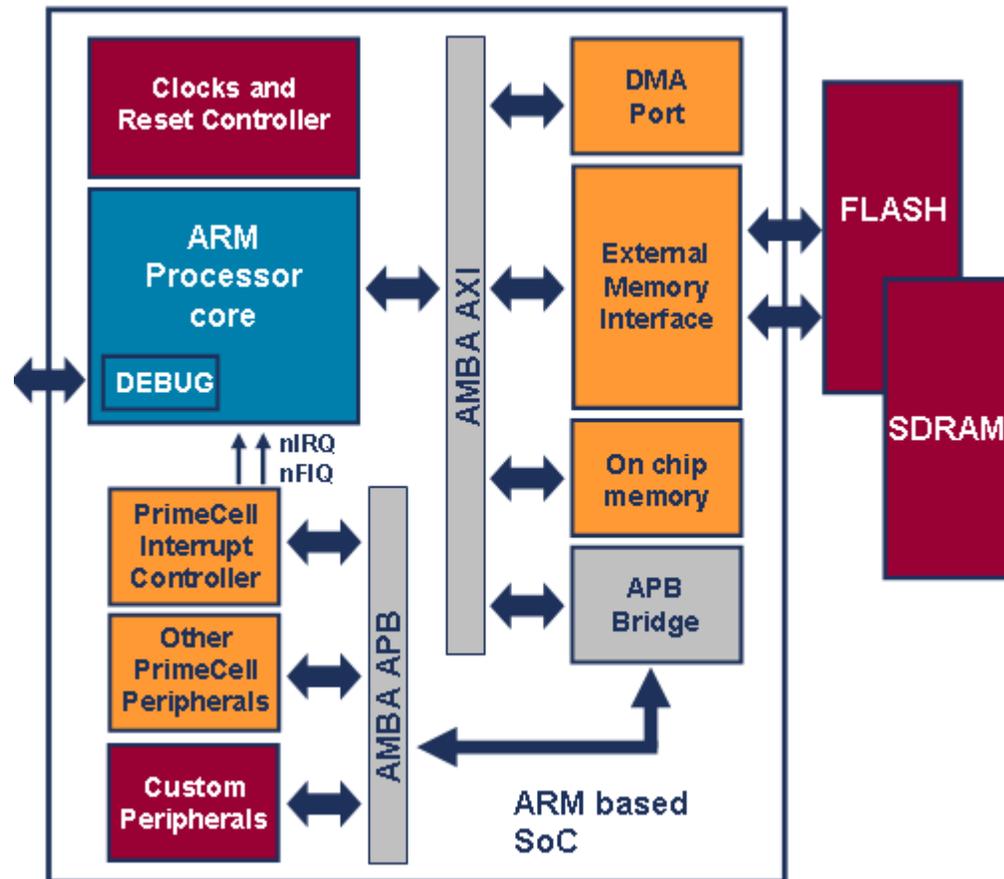


# 向量中断控制系统



# ARM基础系统

}



# TOP6410单板机内存设计-1

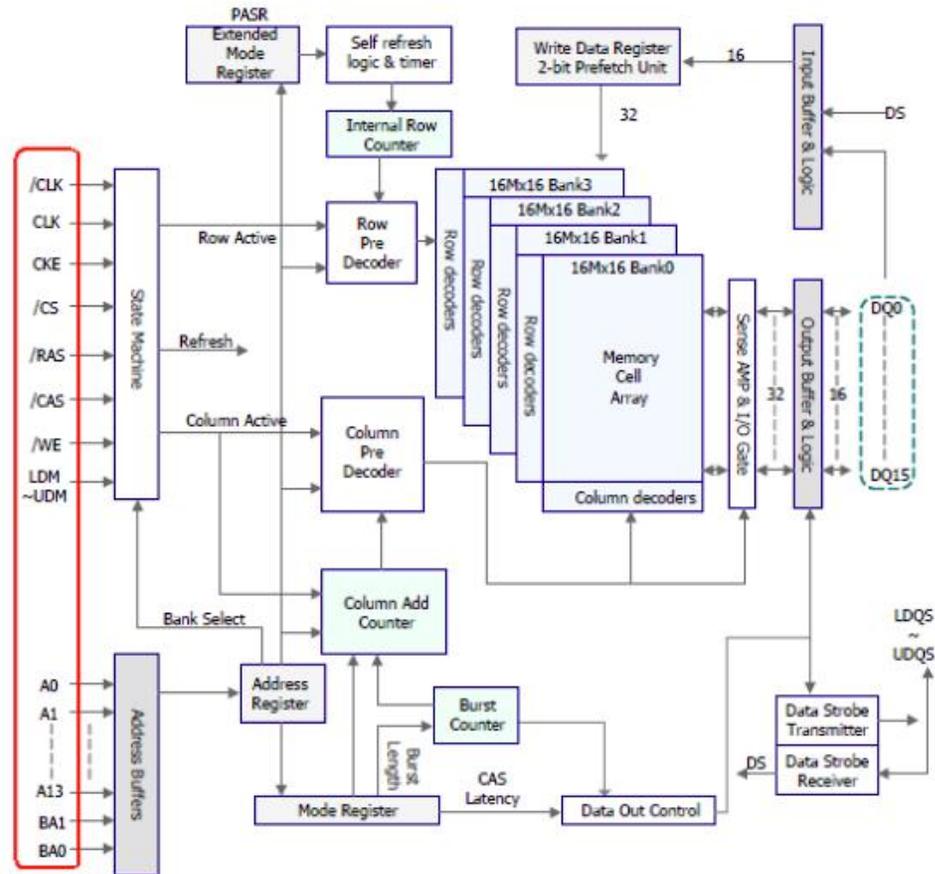
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- } TOP6410采用256M Byte mobile DDR，由两片16位的mobile DDR组成32位宽的256M Byte。
  - } 6410支持Mobile DDR、SDRAM、DDRI。考虑到速度和功耗的原因，由于Mobile DDR（mDDR）有如下特点，故选用其做为开发板的设计。
    - } 低功耗，是常规DDRI的一代
    - } 低电压，1.8V
    - } 支持SLEEP功能
    - } BGA封装，有效降低PCB面积
    - } 一般不需要串端电阻和上拉电阻，设计方便
- 



# TOP6410单板机内存设计-2

16Mbit x 4banks x 16 I/O Mobile DDR SDRAM



如上红框所示为所需的引脚，而 6410 提供的引脚能满足以上要求，



## NAND Flash 和NOR Flash

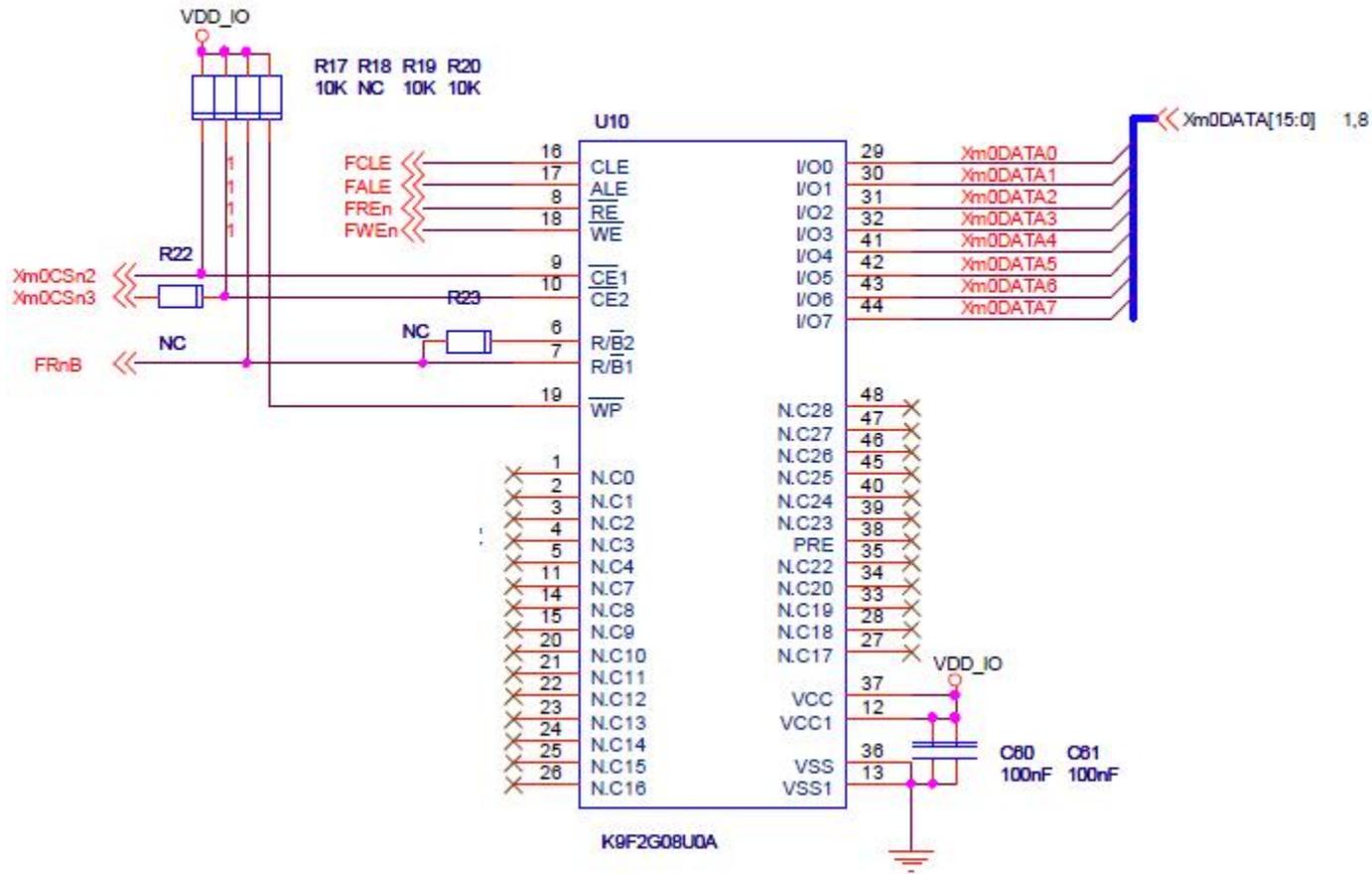
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- } ● NOR的读速度比NAND稍快一些。
- } ● NAND的写入速度比NOR快很多。
- } ● NAND的4ms擦除速度远比NOR的5s快。
- } ● 大多数写入操作需要先进行擦除操作。
- } ● NAND的擦除单元更小，相应的擦除电路更少。



# NAND FLASH 电路设计分析

} S3C6410支持MLC和SLC型 NAND FLASH



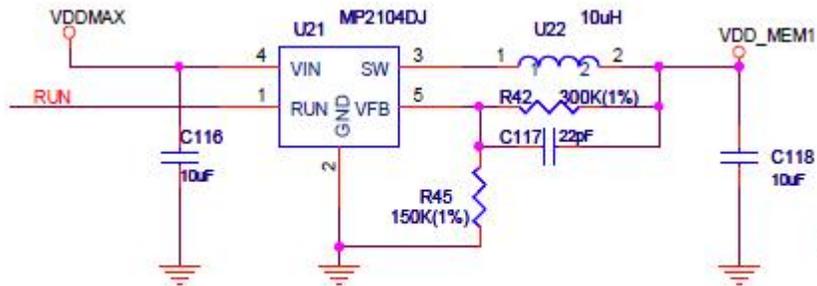
## 电源管理单元的实现

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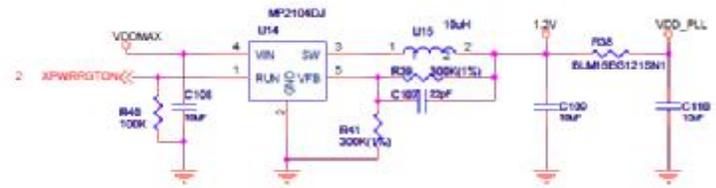
- } 其中需要产生如下电压
  - } 1、VDDIO 3.3V 不受控
  - } 2、VDDARM 1.2V 受控
  - } 3、VDDINT 1.2V 受控
  - } 4、VDDPLL 1.2V 受控
  - } 5、VDDMEM1 1.8V 不受控
  - } 6、VDDALIVE 1.2V 不受控
  - } 7、VDDOTG 3.3V 受控
  - } 8、VDDOTI 1.2V 受控
  - } 9、VDDADC 3.3V 不受控
- 



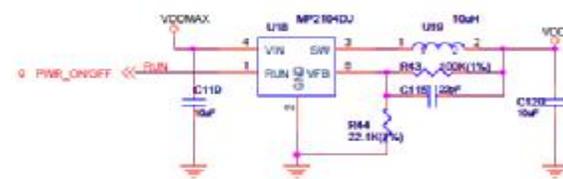
# 电源电路原理图



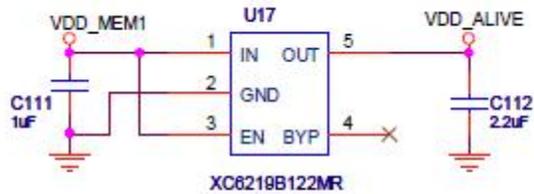
1.8V for mobile DDR



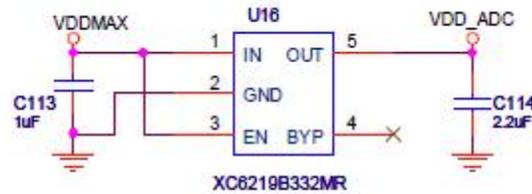
1.2V for PLL INT ARM and OTGI



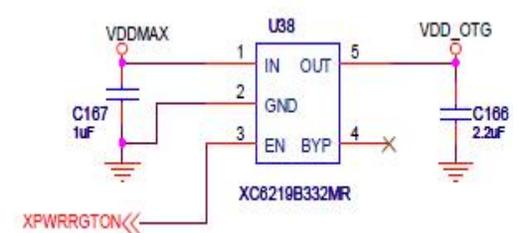
3.3V FOR SYSTEM



1.2V for ALIVE



3.3V FOR ADC or DAC





# 时钟信号设计

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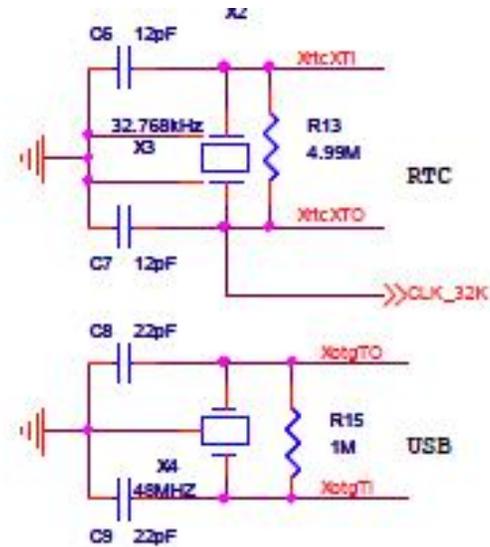
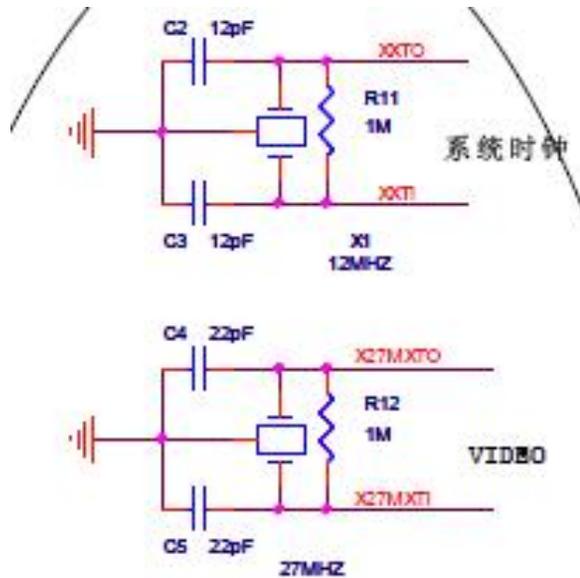
- } 6410需要四路时钟信号，分别如下
  - } 主时钟，12MHZ
  - } Video时钟信号 27HZ，用于显示模块，如MFC LCD TV模块提供时钟信号
  - } USB时钟，48MHZ，用于USB SD卡 SDIO提供时钟信号
  - } RTC时钟，32.768KHZ，用于实时时钟模块提供时钟信号

其是1 2 3可以选择用有源晶振还是无源晶振，除主时钟外，2和3都需要做CPU寄存器的配置才能产生相应的时钟，即选择无源还是有源的。而主时钟用的是有源的还是无源的，由OM0引脚来配置，当OM0拉高时，使用无源晶振，当置低时，使用有源晶振，当使用无源晶振时，XEXTCLK引脚需要拉高。

---



# 时钟设计原理图

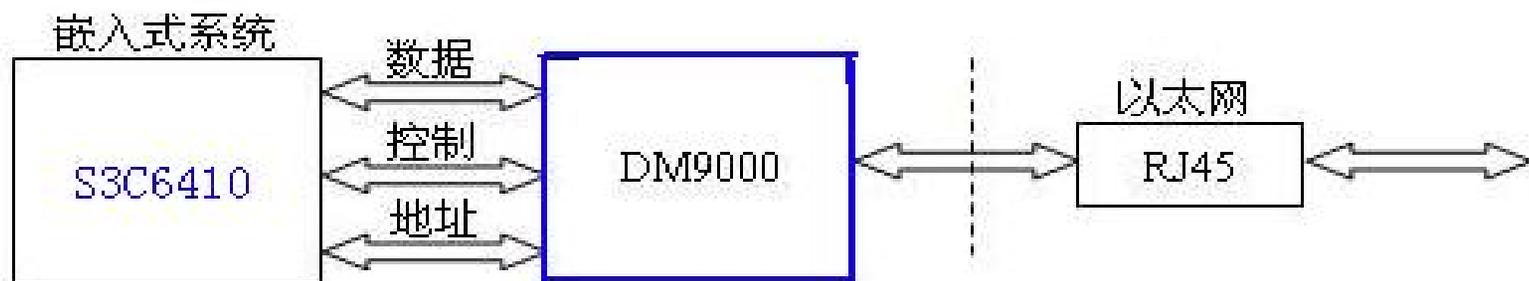


从成本考虑我们选择了无源晶振

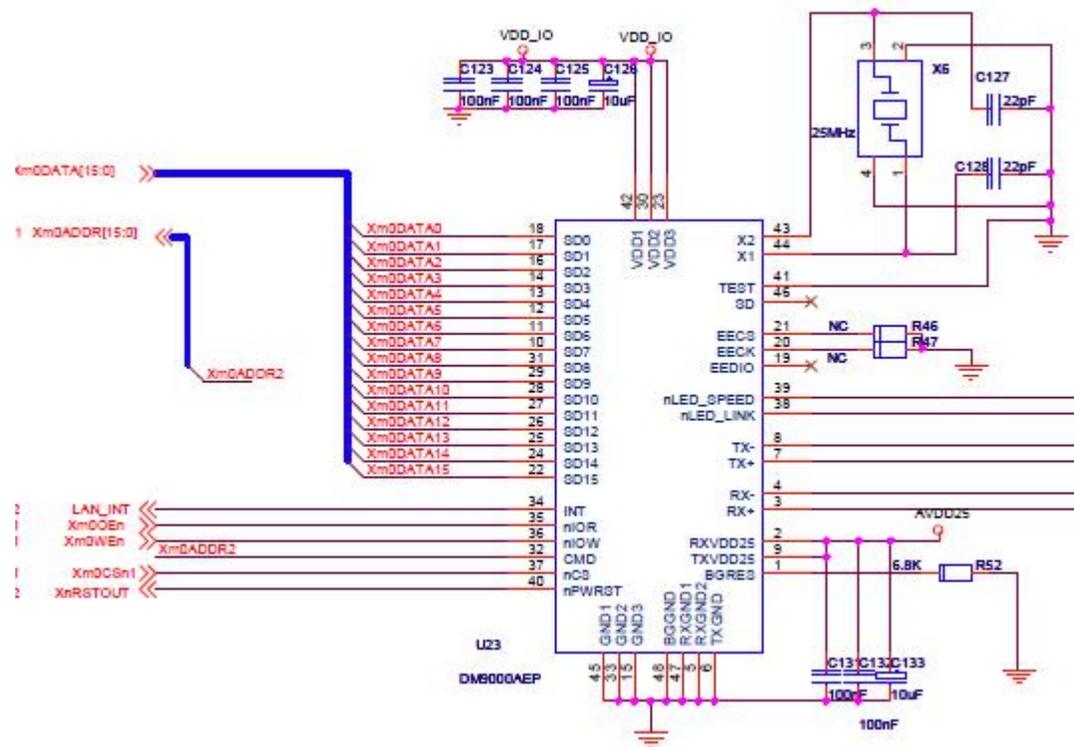


# 网络设计

- DM9000——DAVICOM公司的10/100Mb/s自适应以太网芯片。其特点是：支持8位、16位、32位数据总线宽度；寄存器操作简单有效，有成熟的Linux驱动程序支持；3.3V接口电平；成本相当低廉；



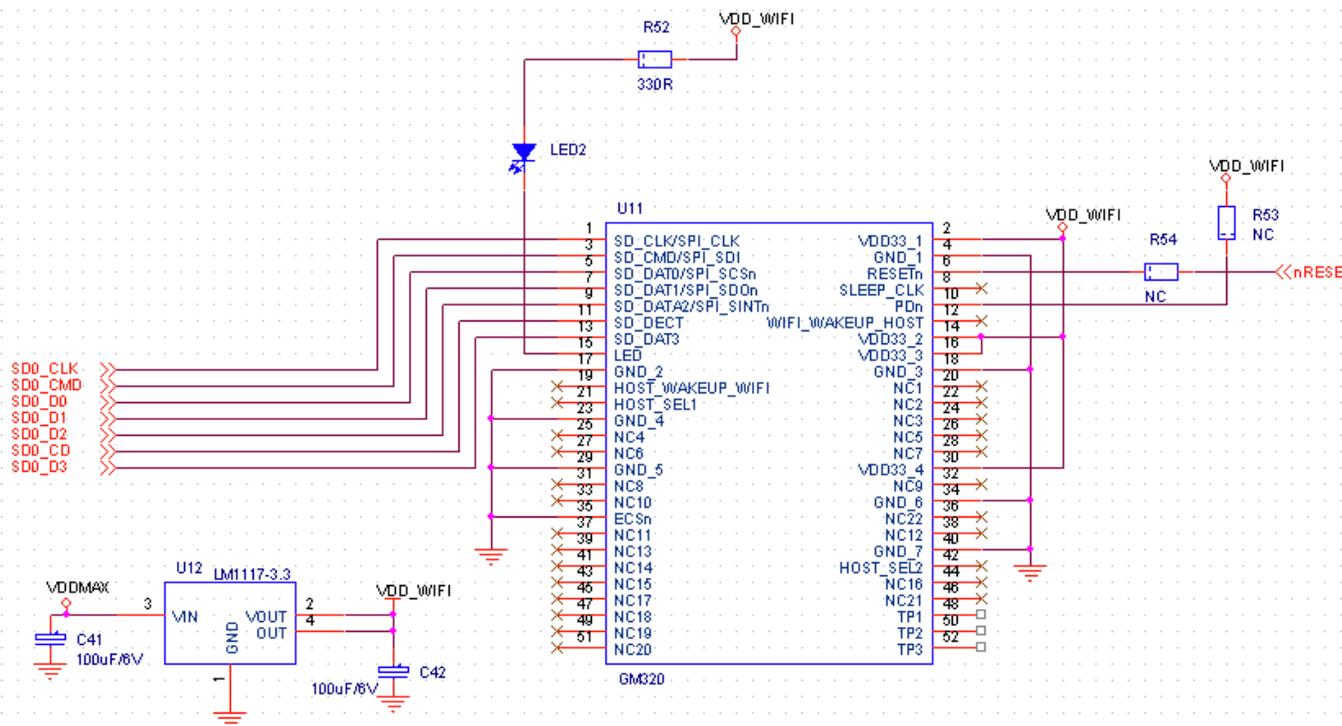
# DM9000原理图设计



DM9000的总线是16位的，接在6410的Xm0的总线上。



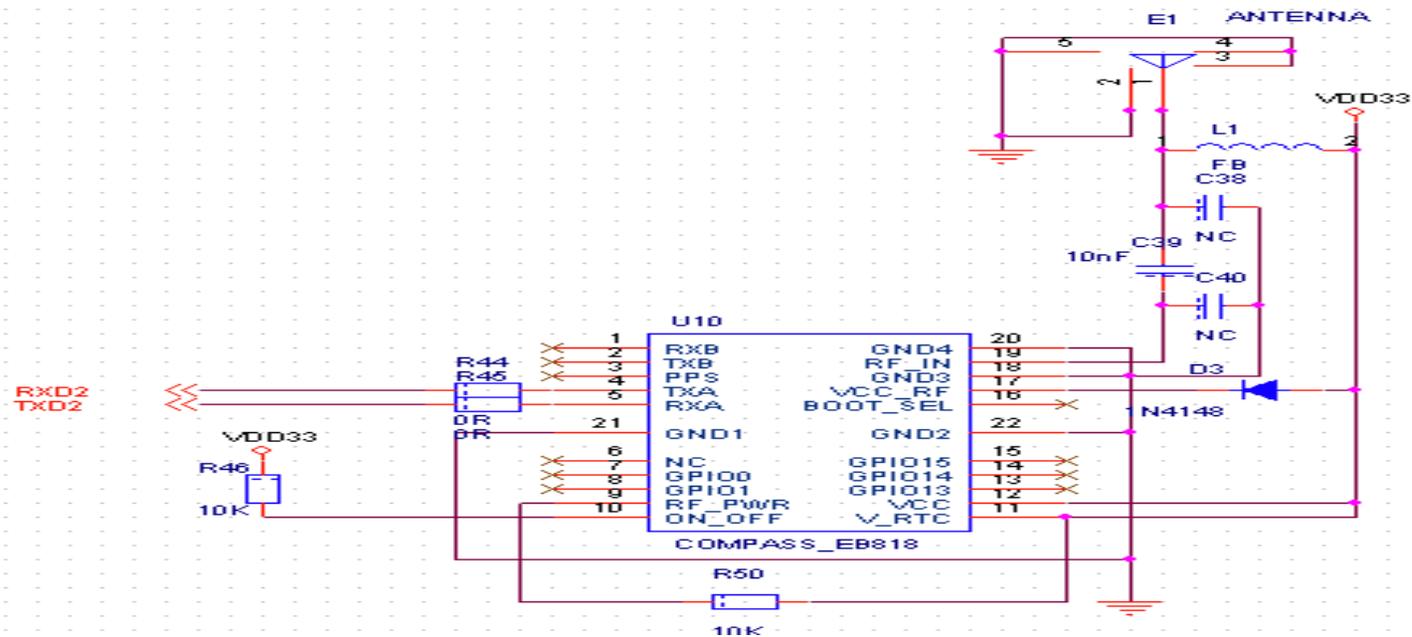
# WiFi电路设计



模块要求3.3V供电，我们采用LDO LM1117-3.3为WiFi模块供电。SD通道0接至WiFi模块的SD接口，图中LED2为连接指示灯，当连接时，LED2会闪烁，连接成功后，LED2灯常亮。由于模块是默认是SD卡接口连接，所以接口选择不接。模块的RESET引脚可以接至CPU的复位引脚，也可以不接。PDn引脚是上电使能引脚，模块默认拉高，低电平关闭模块供电。SD0通道0也接在iNAND上，两者不能同时使用SD0，所以当使用iNAND时，不能使用WiFi模块，反之亦然。



# GPS模块电路设计



GPS模块连接在CPU的串口UART2上，GPS的ON\_OFF引脚是模块的电源使能引脚，高电平打开供电，低电平反之。模块的天线设计部分加多了电阻电容，以便天线灵敏的调节。



## PCB布线分析之差分走线规则

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- } 1、时钟和差分信号线应该尽量短。
  - } 2、高速走线尽量不要有过孔，并且要用45度或圆形的拐角。
  - } 3、不要在晶体，晶振，电感，磁珠以及集成电路下面走线。
  - } 4、信号线要保证在完整的电源和地平面上。
  - } 5、时钟信号与其它走线之间的距离要保持在50mil以上。
  - } 6、关于信号线的宽度和间距见图1。
  - } 7、差分信号线的长度差应该控制在150mil以内。
- 





# DDR布线要求及规范

## } 电源和GND的走线规则

- 一、地层必须紧挨信号层，以提供良好的返回路径。
- 二、地层必须无割裂现象。
- 三、接地管脚的处理：
  - } 过孔必须尽量靠近管脚；
  - } 旁路电容的接地管脚尽量靠近CPU相应接地管脚；
  - } 将靠近的接地管脚用走线连接在一起。

## 四、电源管脚的处理：

- } 旁路电容的电源管脚尽量靠近CPU相应电源管脚；
- } 过孔必须尽量靠近管脚。

在PCB面积允许的条件下，尽可能多的放置旁路电容。

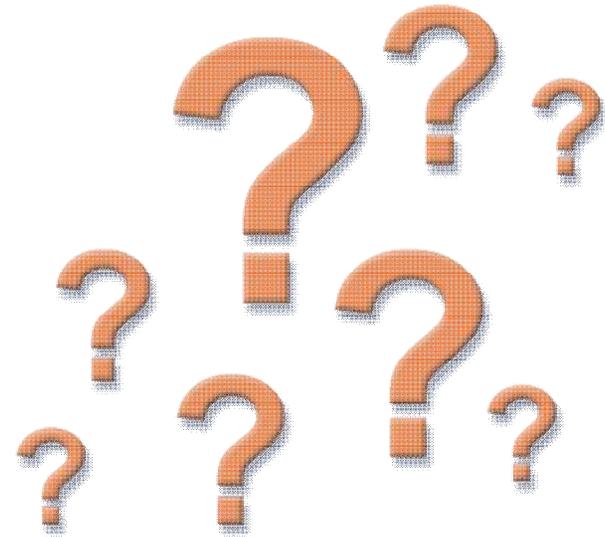
## Ø 数据信号走线规则

- } 数据信号包括DQ，DQM，DQS信号，共分了四个组。
- } 同一小组的信号的的长度匹配必须在1.5mm（约60mil）以内，并且尽量在一个信号层内走线，如果同一组的信号在不同的信号层内走线，必须进行PCB的层的阻抗匹配。

## Ø 时钟信号SCLKn和SCLK走线规则

- } 时钟信号SCLK和SCLKn必须按差分走线方式，时钟信号的长度要比数据信号和地址控制信号都要长。长度关系是：
  - } 数据信号 < 地址控制信号 < 时钟信号
- } 以上三组信号的组间长度差控制在10mm（390mil）以内。
- } 对于DDR部分的阻抗最好控制在50-60欧姆之内

# Q&A





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